

## MAX32655

## Low-Power, Arm Cortex-M4 Processor with FPU-Based Microcontroller and Bluetooth 5.2

### General Description

The MAX32655 microcontroller (MCU) is an advanced system-on-chip (SoC) featuring an Arm® Cortex®-M4F CPU for efficient computation of complex functions and algorithms that is qualified to operate at a temperature range of -40°C to +105°C. The SoC integrates power regulation and management with a single inductor multiple-output (SIMO) buck regulator system. On board is the latest generation Bluetooth® 5.2 Low Energy (LE) radio, supporting LE Audio, angle of arrival (AoA), and angle of departure (AoD) for direction finding, long-range (coded), and high-throughput modes.

The device offers large onboard memory with 512KB flash and 128KB SRAM, with optional error correction coding on one 32KB SRAM bank. This 32KB bank can be optionally retained in BACKUP mode. An 8KB user OTP area is available, of which 8 bytes are retained, even during POWER DOWN mode.

Many high-speed interfaces are supported on the device, including multiple SPI, UART, and I²C serial interfaces, plus one I²S port for connecting to an audio codec. An eight-input, 10-bit ADC is available to monitor analog input from external analog sources.

The MAX32655 is available in a 81 CTBGA (8mm x 8mm, 0.8mm pitch) and a 60 WLP (3.13mm x 3.25mm, 0.35mm pitch).

### Applications

- Asset Tracking
- Fitness/Health and Medical Wearables
- Hearables
- Industrial Sensors
- Wireless Computer Peripherals and I/O Devices

### Benefits and Features

- Ultra-Low-Power Wireless Microcontroller
  - Internal 100MHz Oscillator
  - Flexible Low-Power Modes with 7.3728MHz System Clock Option
  - 512KB Flash and 128KB SRAM
    - Optional ECC on One 32KB SRAM Bank
  - 16KB Instruction Cache
- Bluetooth 5.2 LE Radio
  - Dedicated, Ultra-Low-Power, 32-Bit RISC-V Coprocessor to Offload Timing-Critical Bluetooth Processing
  - Fully Open-Source Bluetooth 5.2 Stack Available
  - Supports AoA, AoD, LE Audio, and Mesh
  - High-Throughput (2Mbps) Mode
  - Long-Range (125kbps and 500kbps) Modes
  - Rx Sensitivity: -97.5dBm; Tx Power: +4.5dBm
  - Single-Ended Antenna Connection (50Ω)
- Power Management Maximizes Battery Life
  - 2.0V to 3.6V Supply Voltage Range
  - Integrated SIMO Power Regulator
  - Dynamic Voltage Scaling (DVS)
  - 23.8µA/MHz Active Current at 3.0V
  - 4.4µA at 3.0V Retention Current for 32KB
  - Selectable SRAM Retention + RTC in Low-Power Modes
- Multiple Peripherals for System Control
  - Up to Two High-Speed SPI Master/Slave
  - Up to Three High-Speed I²C Master/Slave (3.4Mbps)
  - Up to Four UART, One I²S Master/Slave
  - Up to 8-Input, 10-Bit Sigma-Delta ADC 7.8ksps
  - Up to Four Micro-Power Comparators
  - Timers: Up to Four 32-Bit, Two LP, Two Watchdog Timers
  - 1-Wire® Master
  - Up to Four Pulse Train (PWM) Engines
  - RTC with Wake-Up Timer
  - Up to 52 GPIOs
- Security and Integrity
  - Available Secure Boot
  - TRNG Seed Generator
  - AES 128/192/256 Hardware Acceleration Engine

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Bluetooth is a trademark of Bluetooth SIG, Inc.

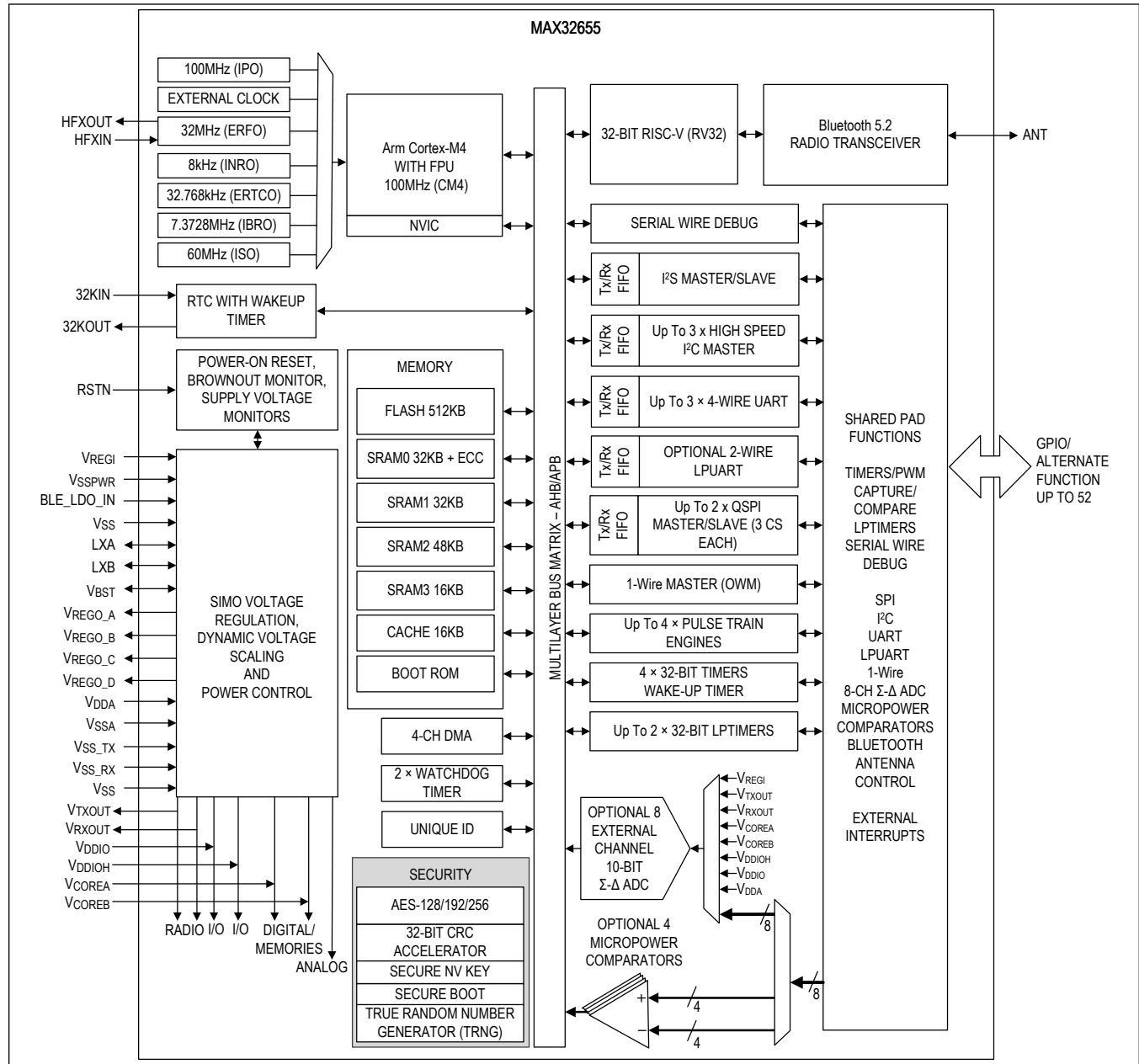
[Ordering Information](#) appears at end of data sheet.

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## Simplified Block Diagram



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## Absolute Maximum Ratings

|                                               |                                    |                                                                                                                            |                 |
|-----------------------------------------------|------------------------------------|----------------------------------------------------------------------------------------------------------------------------|-----------------|
| V <sub>COREA</sub> , V <sub>COREB</sub> ..... | -0.3V to +1.21V                    | V <sub>DDIOH</sub> Combined Pins (sink) .....                                                                              | 100mA           |
| V <sub>DDIO</sub> .....                       | -0.3V to +1.89V                    | V <sub>SSA</sub> .....                                                                                                     | 100mA           |
| V <sub>DDIOH</sub> .....                      | -0.3V to +3.6V                     | V <sub>SS</sub> , V <sub>SS_TX</sub> , V <sub>SS_RX</sub> .....                                                            | 100mA           |
| V <sub>REGI</sub> .....                       | -0.3V to +3.6V                     | V <sub>SSPWR</sub> .....                                                                                                   | 100mA           |
| V <sub>DDA</sub> .....                        | -0.3V to +1.89V                    | Continuous Package Power Dissipation CTBGA (multilayer board) T <sub>A</sub> = +70°C (derate 24.10mW/°C above +70°C) ..... | 1928.18mW       |
| BLE_LDO_IN .....                              | -0.3V to 1.5V                      | Continuous Package Power Dissipation WLP (multilayer board) T <sub>A</sub> = +70°C (derate 22.33mW/°C above +70°C) .....   | 1228mW          |
| RSTN, GPIO (V <sub>DDIOH</sub> ) .....        | -0.3V to V <sub>DDIOH</sub> + 0.5V | Operating Temperature Range .....                                                                                          | -40°C to +105°C |
| GPIO (V <sub>DDIO</sub> ) .....               | -0.3V to V <sub>DDIO</sub> + 0.5V  | Storage Temperature Range .....                                                                                            | -65°C to +150°C |
| 32KIN, 32KOUT .....                           | -0.3V to V <sub>DDA</sub> + 0.2V   | Soldering Temperature .....                                                                                                | +260°C          |
| HFXIN, HFXOUT .....                           | -0.3V to V <sub>DDA</sub> + 0.2V   |                                                                                                                            |                 |
| Output Current (sink) by Any GPIO Pin .....   | 25mA                               |                                                                                                                            |                 |
| Output Current (source) by Any GPIO Pin ..... | -25mA                              |                                                                                                                            |                 |
| V <sub>DDIO</sub> Combined Pins (sink) .....  | 100mA                              |                                                                                                                            |                 |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Package Information

### 81 CTBGA

|                                              |                         |
|----------------------------------------------|-------------------------|
| Package Code                                 | X8188+4C                |
| Outline Number                               | <a href="#">21-0735</a> |
| Land Pattern Number                          | <a href="#">90-0460</a> |
| <b>Thermal Resistance, Four-Layer Board:</b> |                         |
| Junction to Ambient (θ <sub>JA</sub> )       | 41.49°C/W               |
| Junction to Case (θ <sub>JC</sub> )          | 10.81°C/W               |

### 60 WLP

|                                              |                                                |
|----------------------------------------------|------------------------------------------------|
| Package Code                                 | W603B3+1                                       |
| Outline Number                               | <a href="#">21-100635</a>                      |
| Land Pattern Number                          | Refer to <a href="#">Application Note 1891</a> |
| <b>Thermal Resistance, Four-Layer Board:</b> |                                                |
| Junction to Ambient (θ <sub>JA</sub> )       | 44.78°C/W                                      |
| Junction to Case (θ <sub>JC</sub> )          | N/A                                            |

## Electrical Characteristics

(Limits are 100% tested at T<sub>A</sub> = +25°C and T<sub>A</sub> = +105°C. TYP specifications are provided for T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at T<sub>A</sub> = +105°C.)

| PARAMETER                   | SYMBOL             | CONDITIONS | MIN | TYP | MAX  | UNITS |
|-----------------------------|--------------------|------------|-----|-----|------|-------|
| <b>POWER SUPPLIES</b>       |                    |            |     |     |      |       |
| Core Input Supply Voltage A | V <sub>COREA</sub> |            | 0.9 | 1.1 | 1.21 | V     |
| Core Input Supply Voltage B | V <sub>COREB</sub> |            | 0.9 | 1.1 | 1.21 | V     |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^{\circ}\text{C}$  and  $T_A = +105^{\circ}\text{C}$ . TYP specifications are provided for  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^{\circ}\text{C}$ .)

| PARAMETER                         | SYMBOL             | CONDITIONS                   | MIN  | TYP   | MAX  | UNITS |
|-----------------------------------|--------------------|------------------------------|------|-------|------|-------|
| Input Supply Voltage, Battery     | $V_{\text{REGI}}$  | Falling                      | 2.0  | 3.0   | 3.6  | V     |
|                                   |                    | Rising                       | 2.45 | 3.0   | 3.6  |       |
| Input Supply Voltage, Analog      | $V_{\text{DDA}}$   |                              | 1.71 | 1.8   | 1.89 | V     |
| Input Supply Voltage, TXIN        | $V_{\text{TXIN}}$  | Bluetooth transmitter supply | 1.1  | 1.3   | 1.9  | V     |
| Input Supply Voltage, RXIN        | $V_{\text{RXIN}}$  | Bluetooth receiver supply    | 1.1  | 1.3   | 1.9  | V     |
| Input Supply Voltage, GPIO        | $V_{\text{DDIO}}$  |                              | 1.71 | 1.8   | 1.89 | V     |
| Input Supply Voltage, GPIO (High) | $V_{\text{DDIOH}}$ |                              | 1.71 | 3.0   | 3.6  | V     |
| Power-Fail Reset Voltage          | $V_{\text{RST}}$   | Monitors $V_{\text{COREA}}$  |      | 0.76  |      | V     |
|                                   |                    | Monitors $V_{\text{COREB}}$  | 0.72 | 0.77  |      |       |
|                                   |                    | Monitors $V_{\text{DDA}}$    | 1.58 | 1.64  | 1.69 |       |
|                                   |                    | Monitors $V_{\text{DDIO}}$   | 1.58 | 1.64  | 1.69 |       |
|                                   |                    | Monitors $V_{\text{DDIOH}}$  | 1.58 | 1.64  | 1.69 |       |
|                                   |                    | Monitors $V_{\text{REGI}}$   | 1.91 | 1.98  | 2.08 |       |
|                                   |                    | Monitors $V_{\text{RXOUT}}$  |      | 0.773 |      |       |
|                                   |                    | Monitors $V_{\text{TXOUT}}$  |      | 0.773 |      |       |
| Power-On Reset Voltage            | $V_{\text{POR}}$   | Monitors $V_{\text{COREA}}$  |      | 0.57  |      | V     |
|                                   |                    | Monitors $V_{\text{DDA}}$    |      | 1.25  |      |       |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^\circ\text{C}$  and  $T_A = +105^\circ\text{C}$ . TYP specifications are provided for  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^\circ\text{C}$ .)

| PARAMETER                              | SYMBOL                 | CONDITIONS                                                                                                                                                                                                                                                                                                                                                                                                | MIN | TYP  | MAX | UNITS  |
|----------------------------------------|------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|--------|
| V <sub>REGI</sub> Current, ACTIVE Mode | I <sub>REGI_DACT</sub> | Dynamic, IPO enabled, f <sub>SYS_CLK</sub> (MAX) = 100MHz, total current into V <sub>REGI</sub> pin, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 in ACTIVE mode executing Coremark®, RV32 in SLEEP mode, ECC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                             |     | 23.8 |     | μA/MHz |
|                                        |                        | Dynamic, IPO enabled, f <sub>SYS_CLK</sub> (MAX) = 100MHz, total current into V <sub>REGI</sub> pin, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 and RV32 in ACTIVE mode executing While(1), ECC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA. This specification is a function of the IPO frequency. |     | 29.3 |     |        |
|                                        |                        | Dynamic, IPO enabled, f <sub>SYS_CLK</sub> (MAX) = 100MHz, total current into V <sub>REGI</sub> pin, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 in ACTIVE mode executing While(1), RV32 in SLEEP mode, ECC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                              |     | 22.2 |     |        |
|                                        |                        | Dynamic, total current into V <sub>REGI</sub> pin, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 in SLEEP mode, RV32 in ACTIVE mode running from ISO, ECC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                                  |     | 18.7 |     |        |
|                                        | I <sub>REGI_FACT</sub> | Fixed, IPO enabled, ISO enabled, total current into V <sub>REGI</sub> ; V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 in ACTIVE mode 0MHz, RV32 in ACTIVE mode 0MHz; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                                 |     | 740  |     | μA     |
| V <sub>REGI</sub> Current, SLEEP Mode  | I <sub>REGI_DSLP</sub> | Dynamic, IPO enabled, f <sub>SYS_CLK</sub> (MAX) = 100MHz, ISO enabled, total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 in SLEEP mode, RV32 in SLEEP mode, ECC disabled, standard DMA with two channels active; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA             |     | 6.4  |     | μA/MHz |
|                                        | I <sub>REGI_FSLP</sub> | Fixed, IPO enabled, ISO enabled, total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 in SLEEP mode, RV32 in SLEEP mode, ECC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                           |     | 1.33 |     | mA     |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^{\circ}\text{C}$  and  $T_A = +105^{\circ}\text{C}$ . TYP specifications are provided for  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^{\circ}\text{C}$ .)

| PARAMETER                                   | SYMBOL                 | CONDITIONS                                                                                                                                                                                                                                                                                                               |                                  | MIN | TYP  | MAX | UNITS  |
|---------------------------------------------|------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|-----|------|-----|--------|
| V <sub>REGI</sub> Current, LOW POWER Mode   | I <sub>REGI_DLP</sub>  | Dynamic, ISO enabled, total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 powered off, RV32 in ACTIVE mode, f <sub>SYS_CLK(MAX)</sub> = 60MHz; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA |                                  |     | 18.7 |     | μA/MHz |
|                                             | I <sub>REGI_FLP</sub>  | Fixed, ISO enabled, total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, CM4 powered off, RV32 in ACTIVE mode 0MHz; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                 |                                  |     | 630  |     | μA     |
| V <sub>REGI</sub> Current, MICRO POWER Mode | I <sub>REGI_DMP</sub>  | Dynamic, ERTCO enabled, IBRO enabled, total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, LPUART active, f <sub>LPUART</sub> = 32.768kHz; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA          |                                  |     | 230  |     | μA     |
| V <sub>REGI</sub> Current, STANDBY Mode     | I <sub>REGI_STBY</sub> | Fixed, total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                         |                                  |     | 7.1  |     | μA     |
| V <sub>REGI</sub> Current, BACKUP Mode      | I <sub>REGI_BK</sub>   | Total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, RTC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                  | All SRAM retained                |     | 6.3  |     | μA     |
|                                             |                        | Total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, RTC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                  | No SRAM retention                |     | 3    |     |        |
|                                             |                        | Total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V, RTC disabled; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA                                                                                  | SRAM0 retained                   |     | 4.4  |     |        |
|                                             |                        |                                                                                                                                                                                                                                                                                                                          | SRAM0 and SRAM1 retained         |     | 5.2  |     |        |
|                                             |                        |                                                                                                                                                                                                                                                                                                                          | SRAM0, SRAM1, and SRAM2 retained |     | 5.6  |     |        |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^\circ\text{C}$  and  $T_A = +105^\circ\text{C}$ . TYP specifications are provided for  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^\circ\text{C}$ .)

| PARAMETER                                   | SYMBOL                       | CONDITIONS                                                                                                                                                                                                                | MIN              | TYP     | MAX              | UNITS |
|---------------------------------------------|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|---------|------------------|-------|
| V <sub>REGI</sub> Current, POWER DOWN Mode  | I <sub>REGI_PDM</sub>        | Total current into V <sub>REGI</sub> pins, V <sub>REGI</sub> = 3.0V, V <sub>COREA</sub> = V <sub>COREB</sub> = 1.1V; inputs tied to V <sub>SS</sub> , V <sub>DDIO</sub> , or V <sub>DDIOH</sub> ; outputs source/sink 0mA |                  | 0.16    |                  | μA    |
| V <sub>REGO_X</sub> Output Current          | V <sub>REGO_X_IOUT</sub>     | Output current for each of the V <sub>REGO_X</sub> outputs                                                                                                                                                                |                  | 5       | 50               | mA    |
| V <sub>REGO_X</sub> Output Current Combined | V <sub>REGO_X_IOUT_TOT</sub> | All four V <sub>REGO_X</sub> outputs combined                                                                                                                                                                             |                  | 15      | 100              | mA    |
| V <sub>REGO_X</sub> Output Voltage Range    | V <sub>REGO_X_RANGE</sub>    | V <sub>REGI</sub> ≥ V <sub>REGO_X</sub> + 200mV; output voltage range must be configured to meet the input voltage range of the load device pin (V <sub>RST</sub> to V <sub>MAX</sub> )                                   | V <sub>RST</sub> | 1.0     | V <sub>MAX</sub> | V     |
| V <sub>REGO_X</sub> Efficiency              | V <sub>REGO_X_EFF</sub>      | V <sub>REGI</sub> = 2.7V, V <sub>REGO_X</sub> = 1.1V, load = 30mA                                                                                                                                                         |                  | 90      |                  | %     |
| SLEEP Mode Resume Time                      | t <sub>SLP_ON</sub>          | Time from power mode exit to execution of first user instruction                                                                                                                                                          |                  | 0.847   |                  | μs    |
| LOW POWER Mode Resume Time                  | t <sub>LP_ON</sub>           | Time from power mode exit to execution of first user instruction                                                                                                                                                          |                  | 6.08    |                  | μs    |
| MICRO POWER Mode Resume Time                | t <sub>MP_ON</sub>           | Time from power mode exit to execution of first user instruction                                                                                                                                                          |                  | 12.4    |                  | us    |
| STANDBY Mode Resume Time                    | t <sub>STBY_ON</sub>         | Time from power mode exit to execution of first user instruction                                                                                                                                                          |                  | 14.7    |                  | μs    |
| BACKUP Mode Resume Time                     | t <sub>BKU_ON</sub>          | Time from power mode exit to execution of first user instruction                                                                                                                                                          |                  | 1.15    |                  | ms    |
| POWER DOWN Mode Resume Time                 | t <sub>PDM_ON</sub>          | Time from power mode exit to execution of first user instruction                                                                                                                                                          |                  | 5       |                  | ms    |
| <b>CLOCKS</b>                               |                              |                                                                                                                                                                                                                           |                  |         |                  |       |
| System Clock Frequency                      | f <sub>SYS_CLK</sub>         |                                                                                                                                                                                                                           |                  | 100,000 |                  | kHz   |
| Internal Primary Oscillator (IPO)           | f <sub>IPO</sub>             |                                                                                                                                                                                                                           |                  | 100     |                  | MHz   |
| Internal Secondary Oscillator (ISO)         | f <sub>ISO</sub>             |                                                                                                                                                                                                                           |                  | 60      |                  | MHz   |
| Internal Baud Rate Oscillator (IBRO)        | f <sub>IBRO</sub>            |                                                                                                                                                                                                                           |                  | 7.3728  |                  | MHz   |
| Internal Nano-Ring Oscillator (INRO)        | f <sub>INRO</sub>            | 8kHz selected                                                                                                                                                                                                             |                  | 8       |                  | kHz   |
|                                             |                              | 16kHz selected                                                                                                                                                                                                            |                  | 16      |                  |       |
|                                             |                              | 30kHz selected                                                                                                                                                                                                            |                  | 30      |                  |       |
| External RTC Oscillator (ERTCO)             | f <sub>ERTCO</sub>           | 32kHz watch crystal, C <sub>L</sub> = 6pF, ESR < 90kΩ, C <sub>0</sub> ≤ 2pF                                                                                                                                               |                  | 32.768  |                  | kHz   |
| External RF Oscillator Frequency (ERFO)     | f <sub>ERFO</sub>            | 32MHz crystal, C <sub>L</sub> = 12pF, ESR ≤ 50Ω, C <sub>0</sub> ≤ 7pF, temperature stability ±20ppm, initial tolerance ±20ppm                                                                                             |                  | 32      |                  | MHz   |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^{\circ}\text{C}$  and  $T_A = +105^{\circ}\text{C}$ . TYP specifications are provided for  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^{\circ}\text{C}$ .)

| PARAMETER                                            | SYMBOL                      | CONDITIONS                                                                                                 |                                          | MIN | TYP | MAX                      | UNITS |
|------------------------------------------------------|-----------------------------|------------------------------------------------------------------------------------------------------------|------------------------------------------|-----|-----|--------------------------|-------|
| RTC Operating Current                                | I <sub>RTC</sub>            | All power modes, RTC enabled                                                                               |                                          |     | 0.3 |                          | μA    |
| RTC Power-Up Time                                    | t <sub>RTC_ON</sub>         |                                                                                                            |                                          |     | 250 |                          | ms    |
| External System Clock Input Frequency                | f <sub>EXT_CLK</sub>        | EXT_CLK selected                                                                                           |                                          |     |     | 80                       | MHz   |
| External Low-Power Timer 1 Clock Input Frequency     | f <sub>EXT_LPTMR1_CLK</sub> | LPTMR1_CLK selected                                                                                        |                                          |     |     | 8                        | MHz   |
| External Low-Power Timer 2 Clock Input Frequency     | f <sub>EXT_LPTMR2_CLK</sub> | LPTMR2_CLK selected                                                                                        |                                          |     |     | 8                        | MHz   |
| GENERAL-PURPOSE I/O                                  |                             |                                                                                                            |                                          |     |     |                          |       |
| Input Low Voltage for All GPIO Except P3.0 and P3.1  | V <sub>IL_VDDIO</sub>       | P3.0 and P3.1 can only use V <sub>DDIOH</sub> as I/O supply and cannot use V <sub>DDIO</sub> as I/O supply | V <sub>DDIO</sub> selected as I/O supply |     |     | 0.3 × V <sub>DDIO</sub>  | V     |
| Input Low Voltage for All GPIO                       | V <sub>IL_VDDIOH</sub>      | V <sub>DDIOH</sub> selected as I/O supply                                                                  |                                          |     |     | 0.3 × V <sub>DDIOH</sub> | V     |
| Input Low Voltage for RSTN                           | V <sub>IL_RSTN</sub>        |                                                                                                            |                                          |     |     | 0.5 x V <sub>DDIOH</sub> | V     |
| Input High Voltage for All GPIO Except P3.0 and P3.1 | V <sub>IH_VDDIO</sub>       | P3.0 and P3.1 can only use V <sub>DDIOH</sub> as I/O supply and cannot use V <sub>DDIO</sub> as I/O supply | V <sub>DDIO</sub> selected as I/O supply |     |     | 0.7 × V <sub>DDIO</sub>  | V     |
| Input High Voltage for All GPIO                      | V <sub>IH_VDDIOH</sub>      | V <sub>DDIOH</sub> selected as I/O supply                                                                  |                                          |     |     | 0.7 × V <sub>DDIOH</sub> | V     |
| Input High Voltage for RSTN                          | V <sub>IH_RSTN</sub>        |                                                                                                            |                                          |     |     | 0.5 x V <sub>DDIOH</sub> | V     |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^\circ\text{C}$  and  $T_A = +105^\circ\text{C}$ . TYP specifications are provided for  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^\circ\text{C}$ .)

| PARAMETER                                            | SYMBOL                 | CONDITIONS                                                                                                                        |                                                                                                                                 | MIN | TYP | MAX | UNITS |
|------------------------------------------------------|------------------------|-----------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-------|
| Output Low Voltage for All GPIO Except P3.0 and P3.1 | V <sub>OL_VDDIO</sub>  | P3.0 and P3.1 can only use V <sub>DDIOH</sub> as I/O supply and cannot use V <sub>DDIO</sub> as I/O supply                        | V <sub>DDIO</sub> selected as I/O supply, V <sub>DDIO</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 00, I <sub>OL</sub> = 1mA |     | 0.2 | 0.4 | V     |
|                                                      |                        |                                                                                                                                   | V <sub>DDIO</sub> selected as I/O supply, V <sub>DDIO</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 01, I <sub>OL</sub> = 2mA |     | 0.2 | 0.4 |       |
|                                                      |                        |                                                                                                                                   | V <sub>DDIO</sub> selected as I/O supply, V <sub>DDIO</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 10, I <sub>OL</sub> = 4mA |     | 0.2 | 0.4 |       |
|                                                      |                        |                                                                                                                                   | V <sub>DDIO</sub> selected as I/O supply, V <sub>DDIO</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 11, I <sub>OL</sub> = 8mA |     | 0.2 | 0.4 |       |
| Output Low Voltage for All GPIO                      | V <sub>OL_VDDIOH</sub> | V <sub>DDIOH</sub> selected as I/O supply, V <sub>DDIOH</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 00, I <sub>OL</sub> = 1mA |                                                                                                                                 | 0.2 | 0.4 | V   |       |
|                                                      |                        | V <sub>DDIOH</sub> selected as I/O supply, V <sub>DDIOH</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 01, I <sub>OL</sub> = 2mA |                                                                                                                                 | 0.2 | 0.4 |     |       |
|                                                      |                        | V <sub>DDIOH</sub> selected as I/O supply, V <sub>DDIOH</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 10, I <sub>OL</sub> = 4mA |                                                                                                                                 | 0.2 | 0.4 |     |       |
|                                                      |                        | V <sub>DDIOH</sub> selected as I/O supply, V <sub>DDIOH</sub> = 1.71V, GPIO <sub>n_DS_SEL</sub> [1:0] = 11, I <sub>OL</sub> = 8mA |                                                                                                                                 | 0.2 | 0.4 |     |       |
| Combined I <sub>OL</sub> , All GPIO                  | I <sub>OL_TOTAL</sub>  |                                                                                                                                   |                                                                                                                                 |     |     | 48  | mA    |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^\circ\text{C}$  and  $T_A = +105^\circ\text{C}$ . TYP specifications are provided for  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^\circ\text{C}$ .)

| PARAMETER                                             | SYMBOL           | CONDITIONS                                                                                                                                  | MIN               | TYP | MAX  | UNITS |
|-------------------------------------------------------|------------------|---------------------------------------------------------------------------------------------------------------------------------------------|-------------------|-----|------|-------|
| Output High Voltage for All GPIO Except P3.0 and P3.1 | $V_{OH\_VDDIO}$  | $V_{DDIO}$ selected as I/O supply, $V_{DDIO} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 00$ , $I_{OL} = -1\text{mA}$                | $V_{DDIO} - 0.4$  |     |      | V     |
|                                                       |                  | $V_{DDIO}$ selected as I/O supply, $V_{DDIO} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 01$ , $I_{OL} = -2\text{mA}$                | $V_{DDIO} - 0.4$  |     |      |       |
|                                                       |                  | $V_{DDIO}$ selected as I/O supply, $V_{DDIO} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 10$ , $I_{OL} = -4\text{mA}$                | $V_{DDIO} - 0.4$  |     |      |       |
|                                                       |                  | $V_{DDIO}$ selected as I/O supply, $V_{DDIO} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 11$ , $I_{OL} = -8\text{mA}$                | $V_{DDIO} - 0.4$  |     |      |       |
| Output High Voltage for All GPIO Except P3.0 and P3.1 | $V_{OH\_VDDIOH}$ | $V_{DDIOH}$ selected as I/O supply, $V_{DDIOH} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 00$ , $I_{OL} = -1\text{mA}$              | $V_{DDIOH} - 0.4$ |     |      | V     |
|                                                       |                  | $V_{DDIOH}$ selected as I/O supply, $V_{DDIOH} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 01$ , $I_{OL} = -2\text{mA}$              | $V_{DDIOH} - 0.4$ |     |      |       |
|                                                       |                  | $V_{DDIOH}$ selected as I/O supply, $V_{DDIOH} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 10$ , $I_{OL} = -8\text{mA}$              | $V_{DDIOH} - 0.4$ |     |      |       |
|                                                       |                  | $V_{DDIOH}$ selected as I/O supply, $V_{DDIOH} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0] = 11$ , $I_{OL} = -8\text{mA}$              | $V_{DDIOH} - 0.4$ |     |      |       |
| Output High Voltage for P3.0 and P3.1                 | $V_{OH\_VDDIOH}$ | $V_{DDIOH} = 1.71\text{V}$ , $\text{GPIO}_{n\_DS\_SEL}[1:0]$ fixed at 00, $I_{OL} = -1\text{mA}$                                            | $V_{DDIOH} - 0.4$ |     |      | V     |
| Combined $I_{OH}$ , All GPIO                          | $I_{OH\_TOTAL}$  |                                                                                                                                             |                   |     | -48  | mA    |
| Input Hysteresis (Schmitt)                            | $V_{IHYS}$       |                                                                                                                                             |                   | 300 |      | mV    |
| Input Leakage Current Low                             | $I_{IL}$         | $V_{DDIO} = 1.89\text{V}$ , $V_{DDIOH} = 3.6\text{V}$ , $V_{DDIOH}$ selected as I/O supply, $V_{IN} = 0\text{V}$ , internal pullup disabled | -100              |     | +100 | nA    |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^\circ\text{C}$  and  $T_A = +105^\circ\text{C}$ . TYP specifications are provided for  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^\circ\text{C}$ .)

| PARAMETER                                                                                                                                                                                                                                                                                                                                                 | SYMBOL                      | CONDITIONS                                                                                                                                      | MIN  | TYP       | MAX  | UNITS         |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------|-----------|------|---------------|
| Input Leakage Current High                                                                                                                                                                                                                                                                                                                                | $I_{IH}$                    | $V_{DDIO} = 1.89\text{V}$ , $V_{DDIOH} = 3.6\text{V}$ , $V_{DDIOH}$ selected as I/O supply, $V_{IN} = 3.6\text{V}$ , internal pulldown disabled | -800 |           | +800 | nA            |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{OFF}$                   | $V_{DDIO} = 0\text{V}$ , $V_{DDIOH} = 0\text{V}$ , $V_{DDIO}$ selected as I/O supply, $V_{IN} < 1.89\text{V}$                                   | -1   |           | +1   | $\mu\text{A}$ |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{IH3V}$                  | $V_{DDIO} = V_{DDIOH} = 1.71\text{V}$ , $V_{DDIO}$ selected as I/O supply, $V_{IN} = 3.6\text{V}$                                               | -2   |           | +2   |               |
| Input Pullup Resistor RSTN                                                                                                                                                                                                                                                                                                                                | $R_{PU\_R}$                 | Pullup to $V_{DDIOH}$                                                                                                                           |      | 25        |      | k $\Omega$    |
| Input Pullup/Pulldown Resistor for All GPIO                                                                                                                                                                                                                                                                                                               | $R_{PU1}$                   | Normal resistance, P1M = 0                                                                                                                      |      | 25        |      | k $\Omega$    |
|                                                                                                                                                                                                                                                                                                                                                           | $R_{PU2}$                   | Highest resistance, P1M = 1                                                                                                                     |      | 1         |      | M $\Omega$    |
| <b>BLUETOOTH RADIO / POWER</b>                                                                                                                                                                                                                                                                                                                            |                             |                                                                                                                                                 |      |           |      |               |
| Bluetooth LDO Input Voltage                                                                                                                                                                                                                                                                                                                               | $V_{BLE\_LDO\_IN}$          |                                                                                                                                                 | 0.9  | 1.1       | 1.5  | V             |
| <b>BLUETOOTH RADIO / FREQUENCY</b>                                                                                                                                                                                                                                                                                                                        |                             |                                                                                                                                                 |      |           |      |               |
| Operating Frequency                                                                                                                                                                                                                                                                                                                                       |                             | 1MHz channel spacing                                                                                                                            | 2360 |           | 2500 | MHz           |
| PLL Programming Resolution                                                                                                                                                                                                                                                                                                                                | PLLRES                      |                                                                                                                                                 |      | 1         |      | MHz           |
| Frequency Deviation at 1Mbps                                                                                                                                                                                                                                                                                                                              | $\Delta f_{1\text{MHz}}$    |                                                                                                                                                 |      | $\pm 170$ |      | kHz           |
| Frequency Deviation at BLE 1Mbps                                                                                                                                                                                                                                                                                                                          | $\Delta f_{BLE1\text{MHz}}$ |                                                                                                                                                 |      | $\pm 250$ |      | kHz           |
| Frequency Deviation at 2Mbps                                                                                                                                                                                                                                                                                                                              | $\Delta f_{2\text{MHz}}$    |                                                                                                                                                 |      | $\pm 320$ |      | kHz           |
| Frequency Deviation at BLE 2Mbps                                                                                                                                                                                                                                                                                                                          | $\Delta f_{BLE2\text{MHz}}$ |                                                                                                                                                 |      | $\pm 500$ |      | kHz           |
| <b>BLUETOOTH RADIO / CURRENT CONSUMPTION (SIMO enabled, <math>V_{REG1} = 3.3\text{V}</math>. IPO enabled, <math>f_{\text{SYS\_CLK}} = 100\text{MHz}</math>, Bluetooth LE stack running on CM4. Measured at the <math>V_{REG1}</math> device pin, <math>V_{REGO\_B} = 0.9\text{V}</math>, <math>V_{REGO\_C} = 1.0\text{V}</math>, RV32 in SLEEP mode.)</b> |                             |                                                                                                                                                 |      |           |      |               |
| Tx Run Current                                                                                                                                                                                                                                                                                                                                            | $I_{TX\_+4.5\text{DBM}}$    | $P_{RF} = +4.5\text{dBm}$                                                                                                                       |      | 6.35      |      | mA            |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{RFFE\_+4.5\text{DBM}}$  |                                                                                                                                                 |      | 4.3       |      |               |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{TX\_0\text{DBM}}$       | $P_{RF} = 0\text{dBm}$                                                                                                                          |      | 4.17      |      |               |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{RFFE\_0\text{DBM}}$     |                                                                                                                                                 |      | 2.12      |      |               |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{TX\_ -10\text{DBM}}$    | $P_{RF} = -10\text{dBm}$                                                                                                                        |      | 3.65      |      |               |
|                                                                                                                                                                                                                                                                                                                                                           | $I_{RFFE\_ -10\text{DBM}}$  |                                                                                                                                                 |      | 1.65      |      |               |
| Tx Startup Current                                                                                                                                                                                                                                                                                                                                        | $I_{\text{START\_TX}}$      |                                                                                                                                                 |      | 2.05      |      | mA            |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^{\circ}\text{C}$  and  $T_A = +105^{\circ}\text{C}$ . TYP specifications are provided for  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^{\circ}\text{C}$ .)

| PARAMETER                                                                                                                                                                                                                                                                      | SYMBOL                | CONDITIONS                       |                      | MIN    | TYP | MAX | UNITS |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|----------------------------------|----------------------|--------|-----|-----|-------|
| BLUETOOTH RADIO / CURRENT CONSUMPTION (SIMO enabled, V <sub>REGI</sub> = 3.3V. IPO Enabled, f <sub>SYS_CLK</sub> = 100MHz, BLE stack running on CM4. Measured at the V <sub>REGI</sub> device pin, V <sub>REGO_B</sub> = 0.9V, V <sub>REGO_C</sub> = 1.0V, RV32 in SLEEP mode) |                       |                                  |                      |        |     |     |       |
| Rx Run Current                                                                                                                                                                                                                                                                 | I <sub>RX_1M</sub>    | f <sub>RX</sub> = 1Mbps          |                      | 4.0    |     | mA  |       |
|                                                                                                                                                                                                                                                                                | I <sub>RX_2M</sub>    | f <sub>RX</sub> = 2Mbps          |                      | 4.12   |     |     |       |
|                                                                                                                                                                                                                                                                                | I <sub>RFFE_1M</sub>  | f <sub>RX</sub> = 1Mbps          |                      | 1.95   |     |     |       |
|                                                                                                                                                                                                                                                                                | I <sub>RFFE_2M</sub>  | f <sub>RX</sub> = 2Mbps          |                      | 2.07   |     |     |       |
| Rx Startup Current                                                                                                                                                                                                                                                             | I <sub>START_RX</sub> |                                  |                      | 2.05   |     | mA  |       |
| BLUETOOTH RADIO / TRANSMITTER                                                                                                                                                                                                                                                  |                       |                                  |                      |        |     |     |       |
| Maximum Output Power                                                                                                                                                                                                                                                           | P <sub>RF</sub>       |                                  |                      | +4.5   |     | dBm |       |
| RF Power Accuracy                                                                                                                                                                                                                                                              | P <sub>RF_ACC</sub>   |                                  |                      | ±1     |     | dB  |       |
| First Adjacent Channel Transmit Power ±2MHz                                                                                                                                                                                                                                    | P <sub>RF1_1</sub>    | 1Mbps Bluetooth LE               |                      | -30.5  |     | dBc |       |
| First Adjacent Channel Transmit Power ±4MHz                                                                                                                                                                                                                                    | P <sub>RF2_1</sub>    | 1Mbps Bluetooth LE               |                      | -40    |     | dBc |       |
| BLUETOOTH RADIO / RECEIVER                                                                                                                                                                                                                                                     |                       |                                  |                      |        |     |     |       |
| Maximum Received Signal Strength at < 0.1% PER                                                                                                                                                                                                                                 | P <sub>RX_MAX</sub>   |                                  |                      | 0      |     | dBm |       |
| Receiver Sensitivity, Ideal Transmitter                                                                                                                                                                                                                                        | P <sub>SENS_IT</sub>  | Measured with 37 byte payload    | 1Mbps Bluetooth LE   | -97.5  |     | dBm |       |
|                                                                                                                                                                                                                                                                                |                       |                                  | 2Mbps Bluetooth LE   | -94    |     |     |       |
| Receiver Sensitivity, Dirty Transmitter                                                                                                                                                                                                                                        | P <sub>SENS_DT</sub>  | Measured with 37 byte payload    | 1Mbps Bluetooth LE   | -95.5  |     | dBm |       |
|                                                                                                                                                                                                                                                                                |                       |                                  | 2Mbps Bluetooth LE   | -93    |     |     |       |
| Receiver Sensitivity, Long Range Coded                                                                                                                                                                                                                                         | P <sub>SENS_LR</sub>  | Measured with 37 Byte Payload    | 125kbps Bluetooth LE | -105.5 |     | dBm |       |
|                                                                                                                                                                                                                                                                                |                       |                                  | 500kbps Bluetooth LE | -101   |     |     |       |
| C/I Cochannel                                                                                                                                                                                                                                                                  | C/I <sub>1MHz</sub>   | 1Mbps Bluetooth LE               |                      | 6.7    |     | dB  |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>2Mhz</sub>   | 2Mbps Bluetooth LE               |                      | 7      |     |     |       |
| Adjacent Interference                                                                                                                                                                                                                                                          | C/I <sub>+1_1</sub>   | +1MHz offset, 1Mbps Bluetooth LE |                      | -2.5   |     | dBm |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>-1_1</sub>   | -1MHz offset, 1Mbps Bluetooth LE |                      | -2.6   |     |     |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>+2_1</sub>   | +2MHz offset, 1Mbps Bluetooth LE |                      | -22    |     | dB  |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>-2_1</sub>   | -2MHz offset, 1Mbps Bluetooth LE |                      | -24    |     |     |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>+2_2</sub>   | +2MHz offset, 2Mbps Bluetooth LE |                      | -2     |     |     |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>-2_2</sub>   | -2MHz offset, 2Mbps Bluetooth LE |                      | -3     |     |     |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>+4_2</sub>   | +4MHz offset, 2Mbps Bluetooth LE |                      | -32    |     |     |       |
|                                                                                                                                                                                                                                                                                | C/I <sub>-4_2</sub>   | -4MHz offset, 2Mbps Bluetooth LE |                      | -34    |     |     |       |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^\circ\text{C}$  and  $T_A = +105^\circ\text{C}$ . TYP specifications are provided for  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^\circ\text{C}$ .)

| PARAMETER                                                                     | SYMBOL                 | CONDITIONS                                            |                                                                                  | MIN                     | TYP                 | MAX                 | UNITS |
|-------------------------------------------------------------------------------|------------------------|-------------------------------------------------------|----------------------------------------------------------------------------------|-------------------------|---------------------|---------------------|-------|
| Adjacent Interference, (3+n) MHz Offset [n = 0, 1, 2, . . .]                  | C/I <sub>3+MHZ</sub>   | 1Mbps Bluetooth LE                                    |                                                                                  |                         | -34.5               |                     | dB    |
| Adjacent Interference, (6+2n) MHz Offset [n = 0, 1, 2, . . .]                 | C/I <sub>6+MHZ</sub>   | 2Mbps Bluetooth LE                                    |                                                                                  |                         | -34                 |                     | dB    |
| Intermodulation Performance, 1Mbps Bluetooth LE with 3MHz, 4MHz, 5MHz Offset  | P <sub>IMD_1MBPS</sub> | 1Mbps Bluetooth LE                                    |                                                                                  |                         | -38                 |                     | dBm   |
| Intermodulation Performance, 2Mbps Bluetooth LE with 6MHz, 8MHz, 10MHz Offset | P <sub>IMD_2MBPS</sub> | 2Mbps Bluetooth LE                                    |                                                                                  |                         | -38                 |                     | dBm   |
| Received Signal Strength Indicator Accuracy                                   | RSSI <sub>ACC</sub>    |                                                       |                                                                                  |                         | ±3                  |                     | dB    |
| Received Signal Strength Indicator Range                                      | RSSI <sub>RANGE</sub>  |                                                       |                                                                                  |                         | -98 to -50          |                     | dB    |
| ADC (SIGMA-DELTA)                                                             |                        |                                                       |                                                                                  |                         |                     |                     |       |
| Resolution                                                                    |                        |                                                       |                                                                                  |                         | 10                  |                     | Bits  |
| ADC Clock Rate                                                                | f <sub>ACLK</sub>      |                                                       |                                                                                  | 0.1                     |                     | 8                   | MHz   |
| ADC Clock Period                                                              | t <sub>ACLK</sub>      |                                                       |                                                                                  |                         | 1/f <sub>ACLK</sub> |                     | µs    |
| Input Voltage Range                                                           | V <sub>AIN</sub>       | AIN[7:0],<br>ADC_DIVSEL = [00],<br>ADC_CH_SEL = [7:0] | REF_SEL = 0,<br>INPUT_SCALE = 0                                                  | V <sub>SSA</sub> + 0.05 |                     | V <sub>BG</sub>     | V     |
|                                                                               |                        | AIN[7:0],<br>ADC_DIVSEL = [01],<br>ADC_CH_SEL = [7:0] | REF_SCALE = 0,<br>INPUT_SCALE = 0                                                | V <sub>SSA</sub> + 0.05 |                     | 2 x V <sub>BG</sub> |       |
|                                                                               |                        | AIN[7:0],<br>ADC_DIVSEL = [10],<br>ADC_CH_SEL = [7:0] | REF_SCALE = 0,<br>INPUT_SCALE = 0, V <sub>DDIOH</sub> selected as the I/O supply | V <sub>SSA</sub> + 0.05 |                     | V <sub>DDIOH</sub>  |       |
|                                                                               |                        | AIN[7:0],<br>ADC_DIVSEL = [11],<br>ADC_CH_SEL = [7:0] | REF_SEL = 0,<br>INPUT_SCALE = 0, V <sub>DDIOH</sub> selected as the I/O supply   | V <sub>SSA</sub> + 0.05 |                     | V <sub>DDIOH</sub>  |       |
| Input Impedance                                                               | R <sub>AIN</sub>       |                                                       |                                                                                  |                         | 30                  |                     | kΩ    |

**Electrical Characteristics (continued)**

(Limits are 100% tested at  $T_A = +25^{\circ}\text{C}$  and  $T_A = +105^{\circ}\text{C}$ . TYP specifications are provided for  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested. GPIO are only tested at  $T_A = +105^{\circ}\text{C}$ .)

| PARAMETER                       | SYMBOL          | CONDITIONS                                                  | MIN | TYP      | MAX     | UNITS         |
|---------------------------------|-----------------|-------------------------------------------------------------|-----|----------|---------|---------------|
| Analog Input Capacitance        | $C_{AIN}$       | Fixed capacitance to $V_{SSA}$                              |     | 1        |         | pF            |
|                                 |                 | Dynamically switched capacitance                            |     | 250      |         | fF            |
| Integral Nonlinearity           | INL             | Measured at $+25^{\circ}\text{C}$                           |     |          | $\pm 2$ | LSb           |
| Differential Nonlinearity       | DNL             | Measured at $+25^{\circ}\text{C}$                           |     |          | $\pm 1$ | LSb           |
| Offset Error                    | $V_{OS}$        |                                                             |     | $\pm 1$  |         | LSb           |
| ADC Active Current              | $I_{ADC}$       | ADC active, reference buffer enabled, input buffer disabled |     | 102      |         | $\mu\text{A}$ |
| ADC Setup Time                  | $t_{ADC\_SU}$   | Any power-up of ADC clock or ADC bias to CpuAdcStart        |     |          | 10      | $\mu\text{s}$ |
| ADC Output Latency              | $t_{ADC}$       |                                                             |     | 1067     |         | $t_{ACLK}$    |
| ADC Sample Rate                 | $f_{ADC}$       |                                                             |     |          | 7.8     | ksps          |
| ADC Input Leakage               | $I_{ADC\_LEAK}$ | ADC inactive or channel not selected                        |     | 10       |         | nA            |
| Full-Scale Voltage              | $V_{FS}$        | ADC code = 0x3FF                                            |     | 1.2      |         | V             |
| Bandgap Temperature Coefficient | $V_{TEMPCO}$    | Box method                                                  |     | 30       |         | ppm           |
| <b>COMPARATORS</b>              |                 |                                                             |     |          |         |               |
| Input Offset Voltage            | $V_{OFFSET}$    |                                                             |     | $\pm 1$  |         | mV            |
| Input Hysteresis                | $V_{HYST}$      | AINCOMPHYST[1:0] = 00                                       |     | $\pm 23$ |         | mV            |
|                                 |                 | AINCOMPHYST[1:0] = 01                                       |     | $\pm 50$ |         |               |
|                                 |                 | AINCOMPHYST[1:0] = 10                                       |     | $\pm 2$  |         |               |
|                                 |                 | AINCOMPHYST[1:0] = 11                                       |     | $\pm 7$  |         |               |
| Input Voltage Range             | $V_{IN\_CMP}$   | Common-mode range                                           | 0.6 |          | 1.35    | V             |
| <b>FLASH MEMORY</b>             |                 |                                                             |     |          |         |               |
| Flash Erase Time                | $t_{M\_ERASE}$  | Mass erase                                                  |     | 20       |         | ms            |
|                                 | $t_{P\_ERASE}$  | Page erase                                                  |     | 20       |         |               |
| Flash Programming Time per Word | $t_{PROG}$      |                                                             |     | 42       |         | $\mu\text{s}$ |
| Flash Endurance                 |                 |                                                             | 10  |          |         | kcycles       |
| Data Retention                  | $t_{RET}$       | $T_A = +105^{\circ}\text{C}$                                | 10  |          |         | years         |

**Electrical Characteristics—SPI**

(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER                               | SYMBOL     | CONDITIONS                                                        | MIN | TYP          | MAX | UNITS |
|-----------------------------------------|------------|-------------------------------------------------------------------|-----|--------------|-----|-------|
| <b>MASTER MODE</b>                      |            |                                                                   |     |              |     |       |
| SPI Master Operating Frequency for SPI0 | $f_{MCK0}$ | $f_{SYS\_CLK} = 100\text{MHz}$ , $f_{MCK0(MAX)} = f_{SYS\_CLK}/2$ |     |              | 50  | MHz   |
| SPI Master Operating Frequency for SPI1 | $f_{MCK1}$ | $f_{SYS\_CLK} = 100\text{MHz}$ , $f_{MCK1(MAX)} = f_{SYS\_CLK}/4$ |     |              | 25  | MHz   |
| SPI Master SCK Period                   | $t_{MCKX}$ |                                                                   |     | $1/f_{MCKX}$ |     | ns    |

**Electrical Characteristics—SPI (continued)**

(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER                                          | SYMBOL             | CONDITIONS | MIN          | TYP          | MAX | UNITS   |
|----------------------------------------------------|--------------------|------------|--------------|--------------|-----|---------|
| SCK Output Pulse-Width High/Low                    | $t_{MCH}, t_{MCL}$ |            | $t_{MCKX}/2$ |              |     | ns      |
| MOSI Output Hold Time After SCK Sample Edge        | $t_{MOH}$          |            | $t_{MCX}/2$  |              |     | ns      |
| MOSI Output Valid to Sample Edge                   | $t_{MOV}$          |            | $t_{MCKX}/2$ |              |     | ns      |
| MOSI Output Hold Time After SCK Low Idle           | $t_{MLH}$          |            |              | $t_{MCKX}/2$ |     | ns      |
| MISO Input Valid to SCK Sample Edge Setup          | $t_{MIS}$          |            |              | 5            |     | ns      |
| MISO Input to SCK Sample Edge Hold                 | $t_{MIH}$          |            |              | $t_{MCKX}/2$ |     | ns      |
| <b>SLAVE MODE</b>                                  |                    |            |              |              |     |         |
| SPI Slave Operating Frequency                      | $f_{SCK}$          |            |              |              | 50  | MHz     |
| SPI Slave SCK Period                               | $t_{SCK}$          |            |              | $1/f_{SCK}$  |     | ns      |
| SCK Input Pulse-Width High/Low                     | $t_{SCH}, t_{SCL}$ |            |              | $t_{SCK}/2$  |     |         |
| SSx Active to First Shift Edge                     | $t_{SSE}$          |            |              | 10           |     | ns      |
| MOSI Input to SCK Sample Edge Rise/Fall Setup      | $t_{SIS}$          |            |              | 5            |     | ns      |
| MOSI Input from SCK Sample Edge Transition Hold    | $t_{SIH}$          |            |              | 1            |     | ns      |
| MISO Output Valid After SCLK Shift Edge Transition | $t_{SOV}$          |            |              | 5            |     | ns      |
| SCK Inactive to SSx Inactive                       | $t_{SSD}$          |            |              | 10           |     | ns      |
| SSx Inactive Time                                  | $t_{SSH}$          |            |              | $1/f_{SCK}$  |     | $\mu$ s |
| MISO Hold Time After SSx Deassertion               | $t_{SLH}$          |            |              | 10           |     | ns      |

**Electrical Characteristics—I<sup>2</sup>C**

(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER            | SYMBOL    | CONDITIONS                                         | MIN | TYP | MAX | UNITS   |
|----------------------|-----------|----------------------------------------------------|-----|-----|-----|---------|
| <b>STANDARD MODE</b> |           |                                                    |     |     |     |         |
| Output Fall Time     | $t_{OF}$  | Standard mode, from $V_{IH(MIN)}$ to $V_{IL(MAX)}$ |     | 150 |     | ns      |
| SCL Clock Frequency  | $f_{SCL}$ |                                                    | 0   |     | 100 | kHz     |
| Low Period SCL Clock | $t_{LOW}$ |                                                    | 4.7 |     |     | $\mu$ s |

**Electrical Characteristics—I<sup>2</sup>C (continued)**

(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER                                        | SYMBOL              | CONDITIONS                                        | MIN  | TYP | MAX | UNITS |
|--------------------------------------------------|---------------------|---------------------------------------------------|------|-----|-----|-------|
| High Time SCL Clock                              | t <sub>HIGH</sub>   |                                                   | 4.0  |     |     | μs    |
| Setup Time for Repeated Start Condition          | t <sub>SU;STA</sub> |                                                   | 4.7  |     |     | μs    |
| Hold Time for Repeated Start Condition           | t <sub>HD;STA</sub> |                                                   | 4.0  |     |     | μs    |
| Data Setup Time                                  | t <sub>SU;DAT</sub> |                                                   |      | 300 |     | ns    |
| Data Hold Time                                   | t <sub>HD;DAT</sub> |                                                   |      | 10  |     | ns    |
| Rise Time for SDA and SCL                        | t <sub>R</sub>      |                                                   |      | 800 |     | ns    |
| Fall Time for SDA and SCL                        | t <sub>F</sub>      |                                                   |      | 200 |     | ns    |
| Setup Time for a Stop Condition                  | t <sub>SU;STO</sub> |                                                   | 4.0  |     |     | μs    |
| Bus Free Time Between a Stop and Start Condition | t <sub>BUS</sub>    |                                                   | 4.7  |     |     | μs    |
| Data Valid Time                                  | t <sub>VD;DAT</sub> |                                                   | 3.45 |     |     | μs    |
| Data Valid Acknowledge Time                      | t <sub>VD;ACK</sub> |                                                   | 3.45 |     |     | μs    |
| <b>FAST MODE</b>                                 |                     |                                                   |      |     |     |       |
| Output Fall Time                                 | t <sub>OF</sub>     | From V <sub>IH(MIN)</sub> to V <sub>IL(MAX)</sub> |      | 150 |     | ns    |
| Pulse Width Suppressed by Input Filter           | t <sub>SP</sub>     |                                                   |      | 75  |     | ns    |
| SCL Clock Frequency                              | f <sub>SCL</sub>    |                                                   | 0    |     | 400 | kHz   |
| Low Period SCL Clock                             | t <sub>LOW</sub>    |                                                   | 1.3  |     |     | μs    |
| High Time SCL Clock                              | t <sub>HIGH</sub>   |                                                   | 0.6  |     |     | μs    |
| Setup Time for Repeated Start Condition          | t <sub>SU;STA</sub> |                                                   | 0.6  |     |     | μs    |
| Hold Time for Repeated Start Condition           | t <sub>HD;STA</sub> |                                                   | 0.6  |     |     | μs    |
| Data Setup Time                                  | t <sub>SU;DAT</sub> |                                                   |      | 125 |     | ns    |
| Data Hold Time                                   | t <sub>HD;DAT</sub> |                                                   |      | 10  |     | ns    |
| Rise Time for SDA and SCL                        | t <sub>R</sub>      |                                                   |      | 30  |     | ns    |
| Fall Time for SDA and SCL                        | t <sub>F</sub>      |                                                   |      | 30  |     | ns    |
| Setup Time for a Stop Condition                  | t <sub>SU;STO</sub> |                                                   | 0.6  |     |     | μs    |
| Bus Free Time Between a Stop and Start Condition | t <sub>BUS</sub>    |                                                   | 1.3  |     |     | μs    |
| Data Valid Time                                  | t <sub>VD;DAT</sub> |                                                   | 0.9  |     |     | μs    |

**Electrical Characteristics—I<sup>2</sup>C (continued)**

(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER                                        | SYMBOL       | CONDITIONS                          | MIN  | TYP | MAX  | UNITS   |
|--------------------------------------------------|--------------|-------------------------------------|------|-----|------|---------|
| Data Valid Acknowledge Time                      | $t_{VD;ACK}$ |                                     | 0.9  |     |      | $\mu$ s |
| <b>FAST MODE PLUS</b>                            |              |                                     |      |     |      |         |
| Output Fall Time                                 | $t_{OF}$     | From $V_{IH(MIN)}$ to $V_{IL(MAX)}$ |      | 80  |      | ns      |
| Pulse Width Suppressed by Input Filter           | $t_{SP}$     |                                     |      | 75  |      | ns      |
| SCL Clock Frequency                              | $f_{SCL}$    |                                     | 0    |     | 1000 | kHz     |
| Low Period SCL Clock                             | $t_{LOW}$    |                                     | 0.5  |     |      | $\mu$ s |
| High Time SCL Clock                              | $t_{HIGH}$   |                                     | 0.26 |     |      | $\mu$ s |
| Setup Time for Repeated Start Condition          | $t_{SU;STA}$ |                                     | 0.26 |     |      | $\mu$ s |
| Hold Time for Repeated Start Condition           | $t_{HD;STA}$ |                                     | 0.26 |     |      | $\mu$ s |
| Data Setup Time                                  | $t_{SU;DAT}$ |                                     |      | 50  |      | ns      |
| Data Hold Time                                   | $t_{HD;DAT}$ |                                     |      | 10  |      | ns      |
| Rise Time for SDA and SCL                        | $t_R$        |                                     |      | 50  |      | ns      |
| Fall Time for SDA and SCL                        | $t_F$        |                                     |      | 30  |      | ns      |
| Setup Time for a Stop Condition                  | $t_{SU;STO}$ |                                     | 0.26 |     |      | $\mu$ s |
| Bus Free Time Between a Stop and Start Condition | $t_{BUS}$    |                                     | 0.5  |     |      | $\mu$ s |
| Data Valid Time                                  | $t_{VD;DAT}$ |                                     | 0.45 |     |      | $\mu$ s |
| Data Valid Acknowledge Time                      | $t_{VD;ACK}$ |                                     | 0.45 |     |      | $\mu$ s |

**Electrical Characteristics—I<sup>2</sup>S**

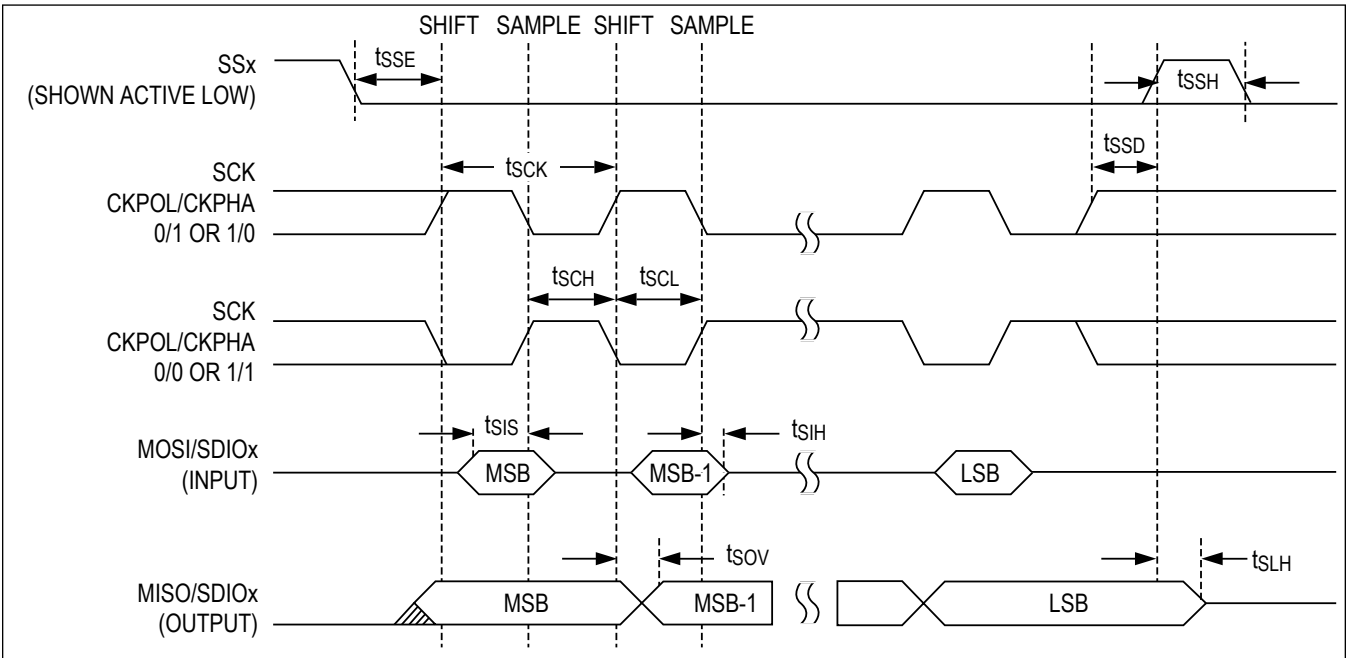
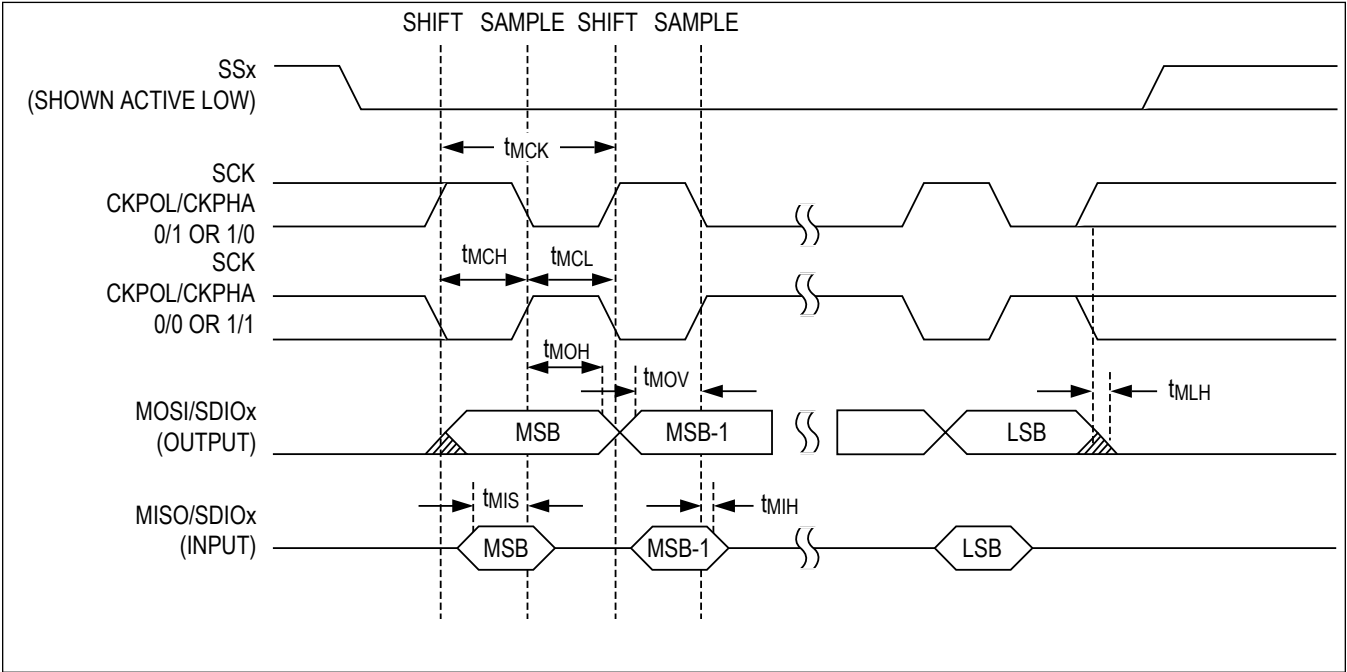
(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER                             | SYMBOL            | CONDITIONS | MIN | TYP                     | MAX | UNITS |
|---------------------------------------|-------------------|------------|-----|-------------------------|-----|-------|
| Bit Clock Frequency                   | $f_{BCLK}$        |            |     |                         | 25  | MHz   |
| BCLK High Time                        | $t_{WBCLKH}$      |            |     | $0.5 \times 1/f_{BCLK}$ |     | ns    |
| BCLK Low Time                         | $t_{WBCLKL}$      |            |     | $0.5 \times 1/f_{BCLK}$ |     | ns    |
| LRCLK Setup Time                      | $t_{LRCLK\_BCLK}$ |            |     | 25                      |     | ns    |
| Delay Time, BCLK to SD (Output) Valid | $t_{BCLK\_SDO}$   |            |     | 12                      |     | ns    |
| Setup Time for SD (Input)             | $t_{SU\_SDI}$     |            |     | 6                       |     | ns    |
| Hold Time SD (Input)                  | $t_{HD\_SDI}$     |            |     | 3                       |     | ns    |

**Electrical Characteristics—1-Wire Master**

(Timing specifications are guaranteed by design and not production tested.)

| PARAMETER              | SYMBOL     | CONDITIONS               | MIN | TYP | MAX | UNITS         |
|------------------------|------------|--------------------------|-----|-----|-----|---------------|
| Write 0 Low Time       | $t_{W0L}$  | Standard                 |     | 60  |     | $\mu\text{s}$ |
|                        |            | Overdrive                |     | 8   |     |               |
| Write 1 Low Time       | $t_{W1L}$  | Standard                 |     | 6   |     | $\mu\text{s}$ |
|                        |            | Standard, Long Line mode |     | 8   |     |               |
|                        |            | Overdrive                |     | 1   |     |               |
| Presence Detect Sample | $t_{MSP}$  | Standard                 |     | 70  |     | $\mu\text{s}$ |
|                        |            | Standard, Long Line mode |     | 85  |     |               |
|                        |            | Overdrive                |     | 9   |     |               |
| Read Data Value        | $t_{MSR}$  | Standard                 |     | 15  |     | $\mu\text{s}$ |
|                        |            | Standard, Long Line mode |     | 24  |     |               |
|                        |            | Overdrive                |     | 3   |     |               |
| Recovery Time          | $t_{REC0}$ | Standard                 |     | 10  |     | $\mu\text{s}$ |
|                        |            | Standard, Long Line mode |     | 20  |     |               |
|                        |            | Overdrive                |     | 4   |     |               |
| Reset Time High        | $t_{RSTH}$ | Standard                 |     | 480 |     | $\mu\text{s}$ |
|                        |            | Overdrive                |     | 58  |     |               |
| Reset Time Low         | $t_{RSTL}$ | Standard                 |     | 600 |     | $\mu\text{s}$ |
|                        |            | Overdrive                |     | 70  |     |               |
| Time Slot              | $t_{SLOT}$ | Standard                 |     | 70  |     | $\mu\text{s}$ |
|                        |            | Overdrive                |     | 12  |     |               |



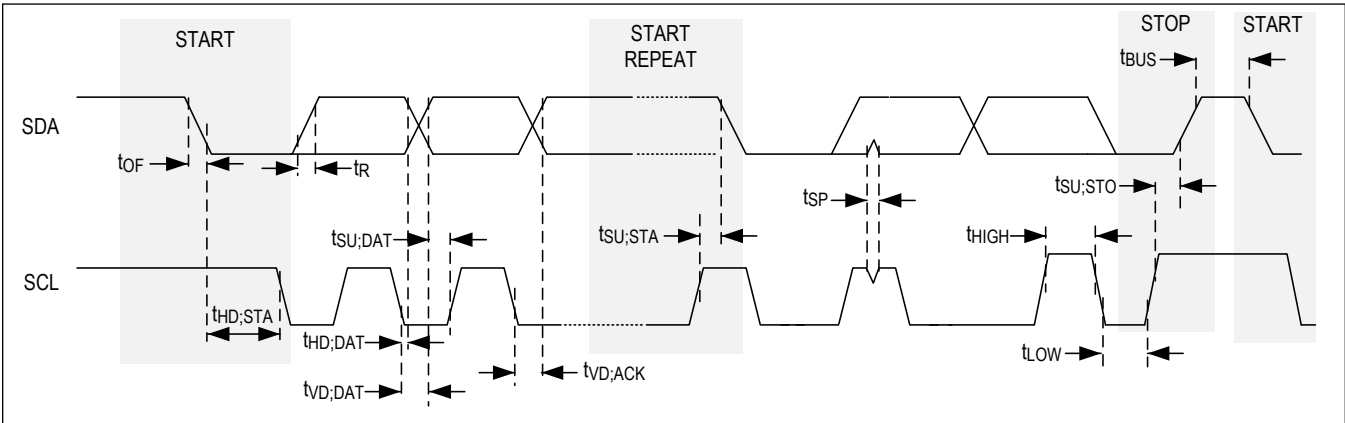


Figure 3. I²C Timing Diagram

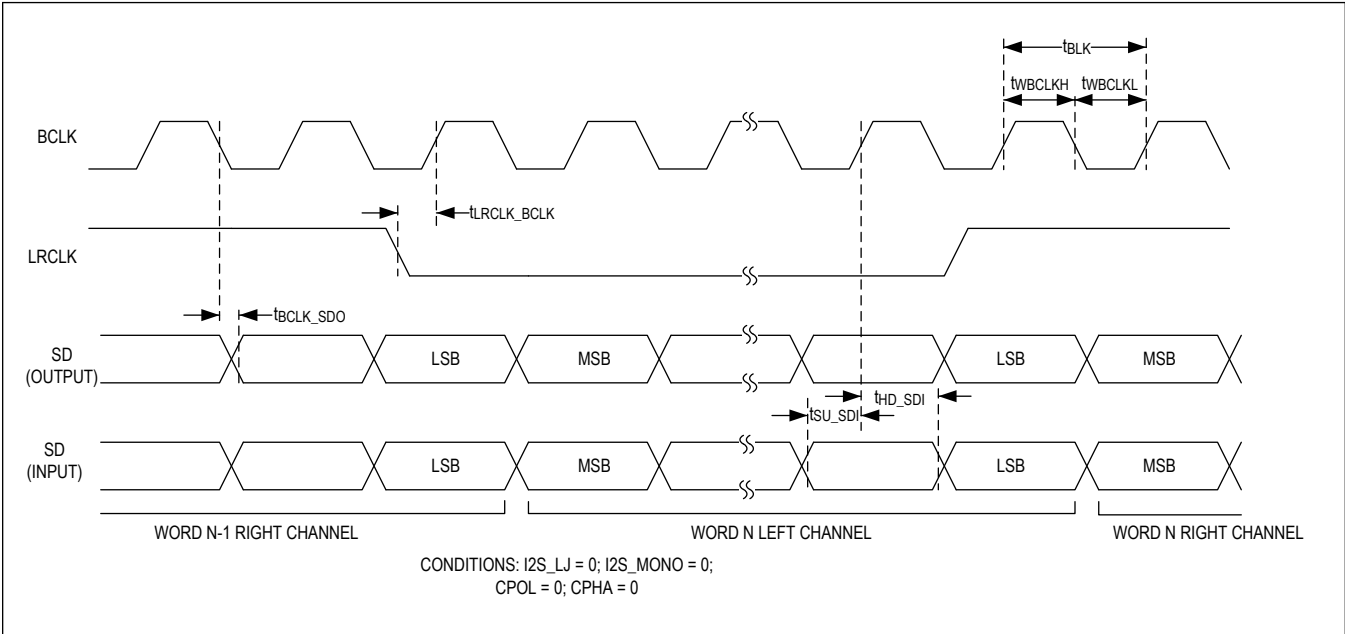


Figure 4. I²S Timing Diagram

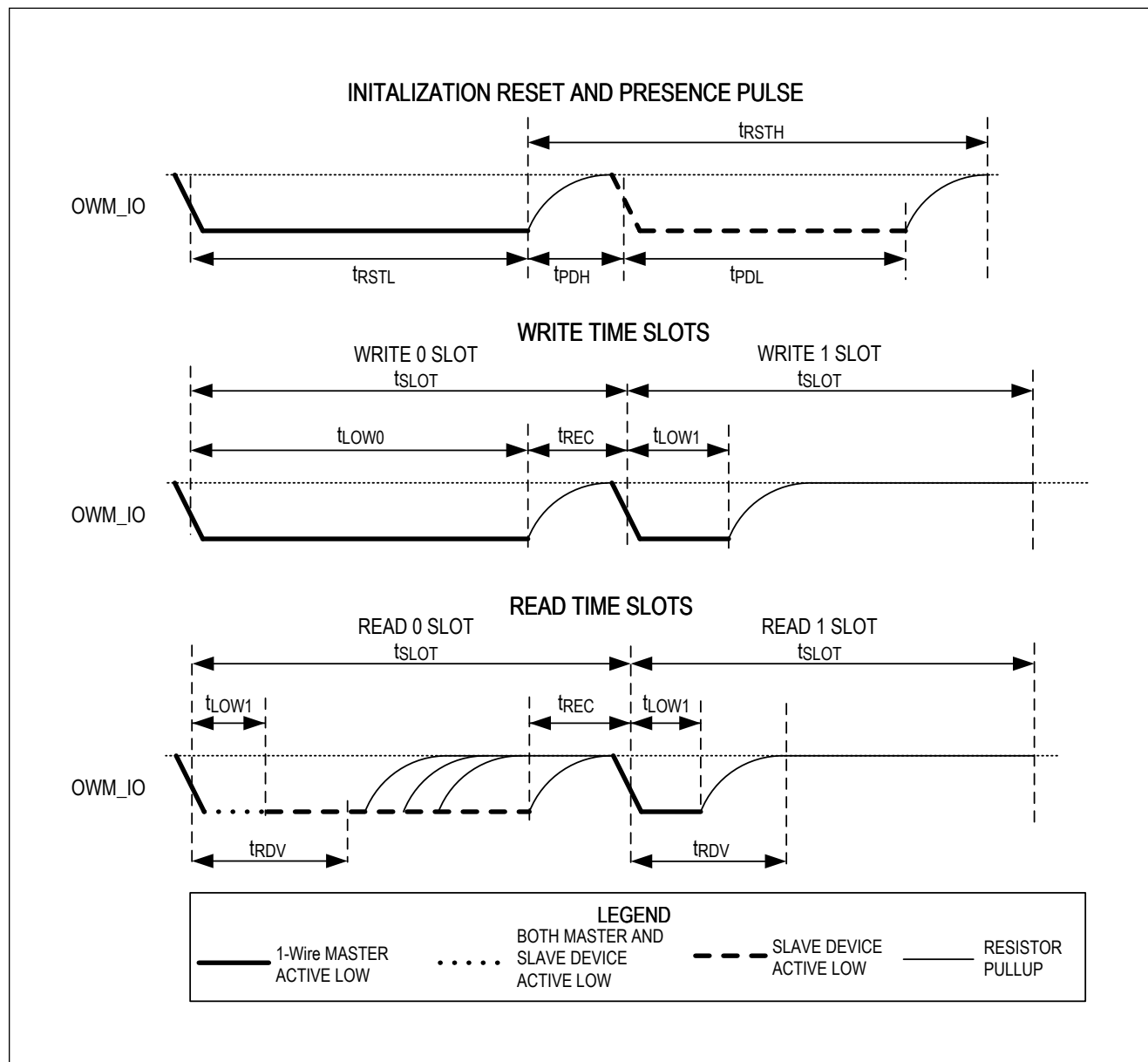
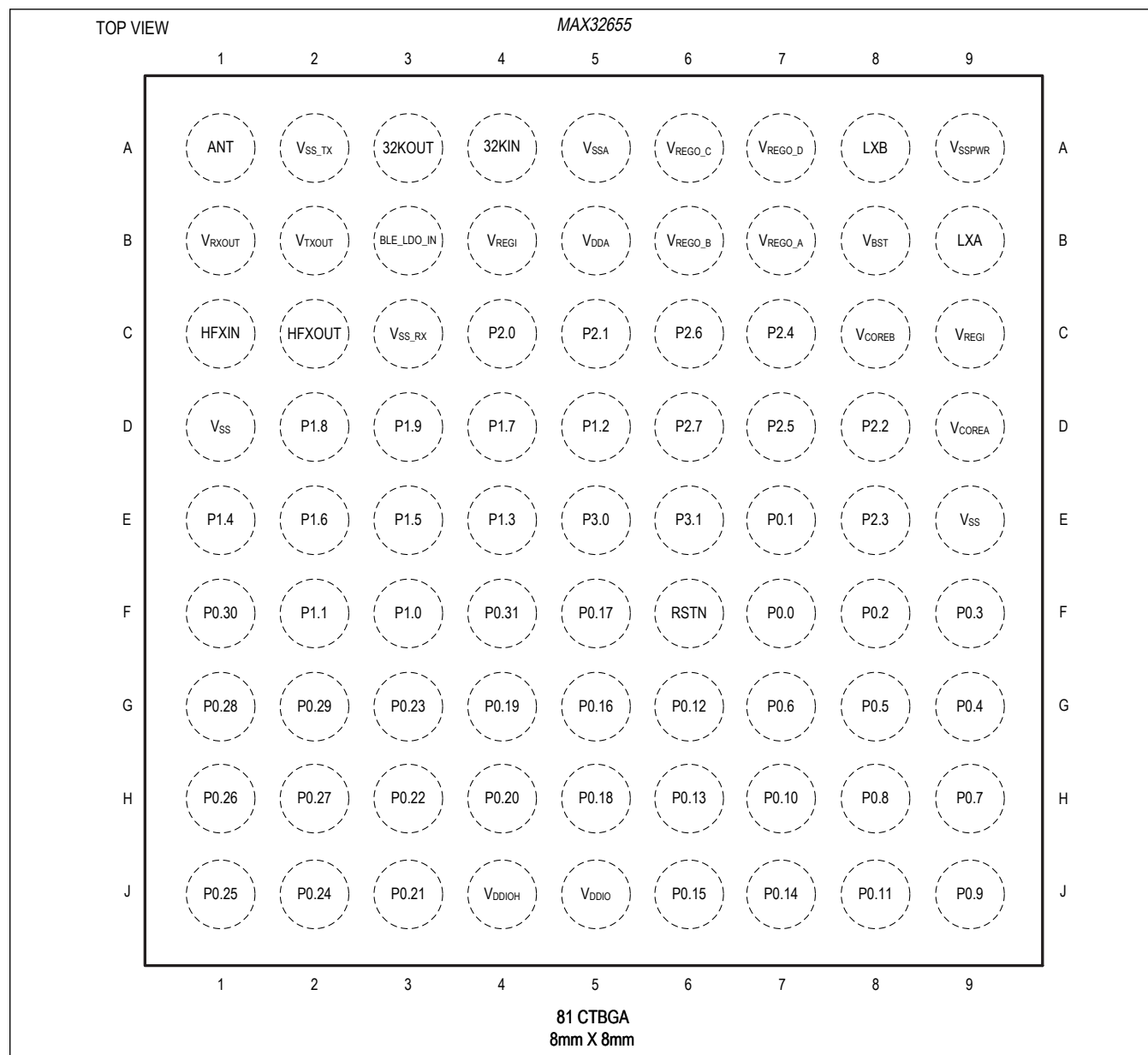


Figure 5. 1-Wire Master Data Timing Diagram

## Pin Configuration

## 81 CTBGA



## Pin Descriptions – 81 CTBGA

| PIN                                                                                                    | NAME                | FUNCTION MODE            |                      |                      | FUNCTION                                                                                                                                                                                                                                                                                                                                                                                                                     |
|--------------------------------------------------------------------------------------------------------|---------------------|--------------------------|----------------------|----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                                                                        |                     | Primary Signal (Default) | Alternate Function 1 | Alternate Function 2 |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| POWER (See the <a href="#">Applications Information</a> section for bypass capacitor recommendations.) |                     |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| C9, B4                                                                                                 | V <sub>REGI</sub>   | —                        | —                    | —                    | Battery Power Supply for the SIMO Switch-Mode Power Supply (SMPS). Bypass device pin C9 with 2 x 47µF capacitors placed as close as possible to the device pin C9 and V <sub>SSPWR</sub> pins for applications using a coin cell as the battery. See <a href="#">Bypass Capacitors</a> for more information. If power to the device is cycled, the voltage applied to this device pin must reach V <sub>REGI</sub> (rising). |
| B3                                                                                                     | BLE_LDO_IN          | —                        | —                    | —                    | Bluetooth LDO Input. Bypass BLE_LDO_IN with a 100nF capacitor to V <sub>SS</sub> placed as close as possible to the BLE_LDO_IN device pin.                                                                                                                                                                                                                                                                                   |
| B5                                                                                                     | V <sub>DDA</sub>    | —                        | —                    | —                    | 1.8V Analog Power Supply                                                                                                                                                                                                                                                                                                                                                                                                     |
| D9                                                                                                     | V <sub>COREA</sub>  | —                        | —                    | —                    | Digital Core Supply Voltage A                                                                                                                                                                                                                                                                                                                                                                                                |
| C8                                                                                                     | V <sub>COREB</sub>  | —                        | —                    | —                    | Digital Core Supply Voltage B                                                                                                                                                                                                                                                                                                                                                                                                |
| B1                                                                                                     | V <sub>RXOUT</sub>  | —                        | —                    | —                    | Radio Receiver Supply Voltage Output. Bypass this pin to V <sub>SS_RX</sub> with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                                                                                                               |
| B2                                                                                                     | V <sub>TXOUT</sub>  | —                        | —                    | —                    | Radio Transmitter Supply Voltage Output. Bypass this pin to V <sub>SS_TX</sub> with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                                                                                                            |
| B8                                                                                                     | V <sub>BST</sub>    | —                        | —                    | —                    | Boosted Supply Voltage for the Gate Drive of High-Side Switches. Bypass V <sub>BST</sub> to LXB with a 3.3nF capacitor.                                                                                                                                                                                                                                                                                                      |
| B7                                                                                                     | V <sub>REGO_A</sub> | —                        | —                    | —                    | Buck Converter A Voltage Output. Bypass V <sub>REGO_A</sub> with a 22µF capacitor to V <sub>SS</sub> placed as close as possible to the V <sub>REGO_A</sub> device pin. This capacitor should be placed on the PCB trace between the V <sub>REGO_A</sub> device pin and the V <sub>DDA</sub> device pin.                                                                                                                     |
| B6                                                                                                     | V <sub>REGO_B</sub> | —                        | —                    | —                    | Buck Converter B Voltage Output. Bypass V <sub>REGO_B</sub> with a 22µF capacitor to V <sub>SS</sub> placed as close as possible to the V <sub>REGO_B</sub> device pin. This capacitor should be placed on the PCB trace between the V <sub>REGO_B</sub> device pin and the closest V <sub>COREB</sub> device pin.                                                                                                           |
| A6                                                                                                     | V <sub>REGO_C</sub> | —                        | —                    | —                    | Buck Converter C Voltage Output. Bypass V <sub>REGO_C</sub> with a 22µF capacitor to V <sub>SS</sub> placed as close as possible to the V <sub>REGO_C</sub> device pin. This capacitor should be placed on the PCB trace between the V <sub>REGO_C</sub> device pin and the closest V <sub>COREA</sub> device pin.                                                                                                           |

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| PIN                                | NAME    | FUNCTION MODE            |                      |                      | FUNCTION                                                                                                                                                                                                                                                                                                                                     |
|------------------------------------|---------|--------------------------|----------------------|----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                    |         | Primary Signal (Default) | Alternate Function 1 | Alternate Function 2 |                                                                                                                                                                                                                                                                                                                                              |
| A7                                 | VREGO_D | —                        | —                    | —                    | Buck Converter D Voltage Output. Bypass VREGO_D with a 22µF capacitor to VSS placed as close as possible to the VREGO_D device pin. This capacitor should be placed on the PCB trace between the VREGO_D device pin and the BLE_LDO_IN device pin.                                                                                           |
| J5                                 | VDDIO   | —                        | —                    | —                    | GPIO Supply Voltage. Bypass this pin to VSS with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                                                               |
| J4                                 | VDDIOH  | —                        | —                    | —                    | GPIO Supply Voltage, High. $V_{DDIOH} \geq V_{DDIO}$ . Bypass this pin to VSS with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                             |
| D1, E9                             | VSS     | —                        | —                    | —                    | Digital Ground                                                                                                                                                                                                                                                                                                                               |
| A5                                 | VSSA    | —                        | —                    | —                    | Analog Ground                                                                                                                                                                                                                                                                                                                                |
| A9                                 | VSSPWR  | —                        | —                    | —                    | Ground for the SIMO SMPS. This device pin is the return path for VREGI device pins C6 and C9.                                                                                                                                                                                                                                                |
| C3                                 | VSS_RX  | —                        | —                    | —                    | Bluetooth Receiver Ground                                                                                                                                                                                                                                                                                                                    |
| A2                                 | VSS_TX  | —                        | —                    | —                    | Bluetooth Transmitter Ground                                                                                                                                                                                                                                                                                                                 |
| B9                                 | LXA     | —                        | —                    | —                    | Switching Inductor Input A. Connect a 2.2µH inductor between LXA and LXB.                                                                                                                                                                                                                                                                    |
| A8                                 | LXB     | —                        | —                    | —                    | Switching Inductor Input B. Connect a 2.2µH inductor between LXA and LXB.                                                                                                                                                                                                                                                                    |
| <b>RESET AND CONTROL</b>           |         |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                              |
| F6                                 | RSTN    | —                        | —                    | —                    | Active-Low, External System Reset Input. The device remains in reset while this pin is in its active state. When the pin transitions to its inactive state, the device performs a POR (resetting all logic on all supplies except for real-time clock circuitry) and begins execution. This pin has an internal pullup to the VDDIOH supply. |
| <b>CLOCK</b>                       |         |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                              |
| A3                                 | 32KOUT  | —                        | —                    | —                    | 32kHz Crystal Oscillator Output                                                                                                                                                                                                                                                                                                              |
| A4                                 | 32KIN   | —                        | —                    | —                    | 32kHz Crystal Oscillator Input. Connect a 32kHz crystal between 32KIN and 32KOUT for RTC operation. Optionally, this pin can be configured as the input for an external CMOS-level clock source.                                                                                                                                             |
| C2                                 | HFXOUT  | —                        | —                    | —                    | 32MHz Crystal Oscillator Output                                                                                                                                                                                                                                                                                                              |
| C1                                 | HFXIN   | —                        | —                    | —                    | 32MHz Crystal Oscillator Input. Connect a 32MHz crystal between HFXIN and HFXOUT for Bluetooth operation. Optionally, this pin can be configured as the input for an external CMOS-level clock source.                                                                                                                                       |
| <b>GPIO AND ALTERNATE FUNCTION</b> |         |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                              |
| F7                                 | P0.0    | P0.0                     | UART0A_RX            | —                    | UART0 Receive Port Map A                                                                                                                                                                                                                                                                                                                     |

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| PIN | NAME  | FUNCTION MODE            |                       |                      | FUNCTION                                                                                                 |
|-----|-------|--------------------------|-----------------------|----------------------|----------------------------------------------------------------------------------------------------------|
|     |       | Primary Signal (Default) | Alternate Function 1  | Alternate Function 2 |                                                                                                          |
| E7  | P0.1  | P0.1                     | UART0A_TX             | —                    | UART0 Transmit Port Map A                                                                                |
| F8  | P0.2  | P0.2                     | TMR0A_IOA             | UART0B_CTS           | Timer 0 I/O 32 Bits or Lower 16 Bits Port Map A; UART0 Clear to Send Port Map B                          |
| F9  | P0.3  | P0.3                     | EXT_CLK/<br>TMR0A_IOB | UART0B_RTS           | External Clock for Use as SYS_OSC/Timer 0 I/O Upper 16 Bits Port Map A; UART0 Request to Send Port Map B |
| G9  | P0.4  | P0.4                     | SPI0_SS0              | TMR0B_IOAN           | SPI0 Slave Select 0; Timer 0 Inverted Output Port Map B                                                  |
| G8  | P0.5  | P0.5                     | SPI0_MOSI             | TMR0B_IOBN           | SP0 Master Out Slave In Serial Data 0; 32-bit Timer 0 Inverted Output Upper 16 Bits Port Map B           |
| G7  | P0.6  | P0.6                     | SPI0_MISO             | OWM_IO               | SPI0 Master In Slave Out Serial Data 1; 1-Wire Master Data I/O                                           |
| H9  | P0.7  | P0.7                     | SPI0_SCK              | OWM_PE               | SPI0 Clock; 1-Wire Master Pullup Enable Output                                                           |
| H8  | P0.8  | P0.8                     | SPI0_SDIO2            | TMR0B_IOA            | SPI0 Data 2 I/O; Timer 0 I/O 32 Bits or Lower 16 Bits Port Map B                                         |
| J9  | P0.9  | P0.9                     | SPI0_SDIO3            | TMR0B_IOB            | SPI0 Data 3 I/O; Timer 0 I/O Upper 16 Bits Port Map B                                                    |
| H7  | P0.10 | P0.10                    | I2C0_SCL              | SPI0_SS2             | I2C0 Clock; SPI0 Slave Select 2                                                                          |
| J8  | P0.11 | P0.11                    | I2C0_SDA              | SPI0_SS1             | I2C0 Serial Data; SPI0 Slave Select 1                                                                    |
| G6  | P0.12 | P0.12                    | UART1A_RX             | TMR1B_IOAN           | UART1 Receive Port Map A; Timer 1 Inverted Output Port Map B                                             |
| H6  | P0.13 | P0.13                    | UART1A_TX             | TMR1B_IOBN           | UART1 Transmit Port Map A; Timer 1 Inverted Output Upper 16 Bits Port Map B                              |
| J7  | P0.14 | P0.14                    | TMR1A_IOA             | UART1B_CTS           | Timer 1 I/O 32 Bits or Lower 16 Bits Port Map A; UART1 Clear to Send Port Map B                          |
| J6  | P0.15 | P0.15                    | TMR1A_IOB             | UART1B_RTS           | Timer 1 I/O Upper 16 Bits Port Map A; UART1 Request to Send Port Map B                                   |
| G5  | P0.16 | P0.16                    | I2C1_SCL              | PT2                  | I2C1 Clock; Pulse Train 2                                                                                |
| F5  | P0.17 | P0.17                    | I2C1_SDA              | PT3                  | I2C1 Serial Data; Pulse Train 3                                                                          |
| H5  | P0.18 | P0.18                    | PT0                   | OWM_IO               | Pulse Train 0; 1-Wire Master Data I/O                                                                    |
| G4  | P0.19 | P0.19                    | PT1                   | OWM_PE               | Pulse Train 1; 1-Wire Master Pullup Enable Output                                                        |
| H4  | P0.20 | P0.20                    | SPI1_SS0              | TMR1B_IOA            | SPI1 Slave Select 0; Timer 1 I/O 32 Bits or Lower 16 Bits Port Map B                                     |
| J3  | P0.21 | P0.21                    | SPI1_MOSI             | TMR1B_IOB            | SPI1_Master Out Slave In Serial Data 0; Timer 1 I/O Upper 16 Bits Port Map B                             |
| H3  | P0.22 | P0.22                    | SPI1_MISO             | TMR1B_IOAN           | SPI1 Master In Slave Out Serial Data 1; Timer 1 Inverted Output Port Map B                               |
| G3  | P0.23 | P0.23                    | SPI1_SCK              | TMR1B_IOBN           | SPI1 Clock; Timer 1 Inverted Output Upper 16 Bits Port Map B                                             |
| J2  | P0.24 | P0.24                    | SPI1_SDIO2            | TMR2B_IOA            | SPI1 Data 2; Timer 2 I/O 32 Bits or Lower 16 Bits Port Map B                                             |

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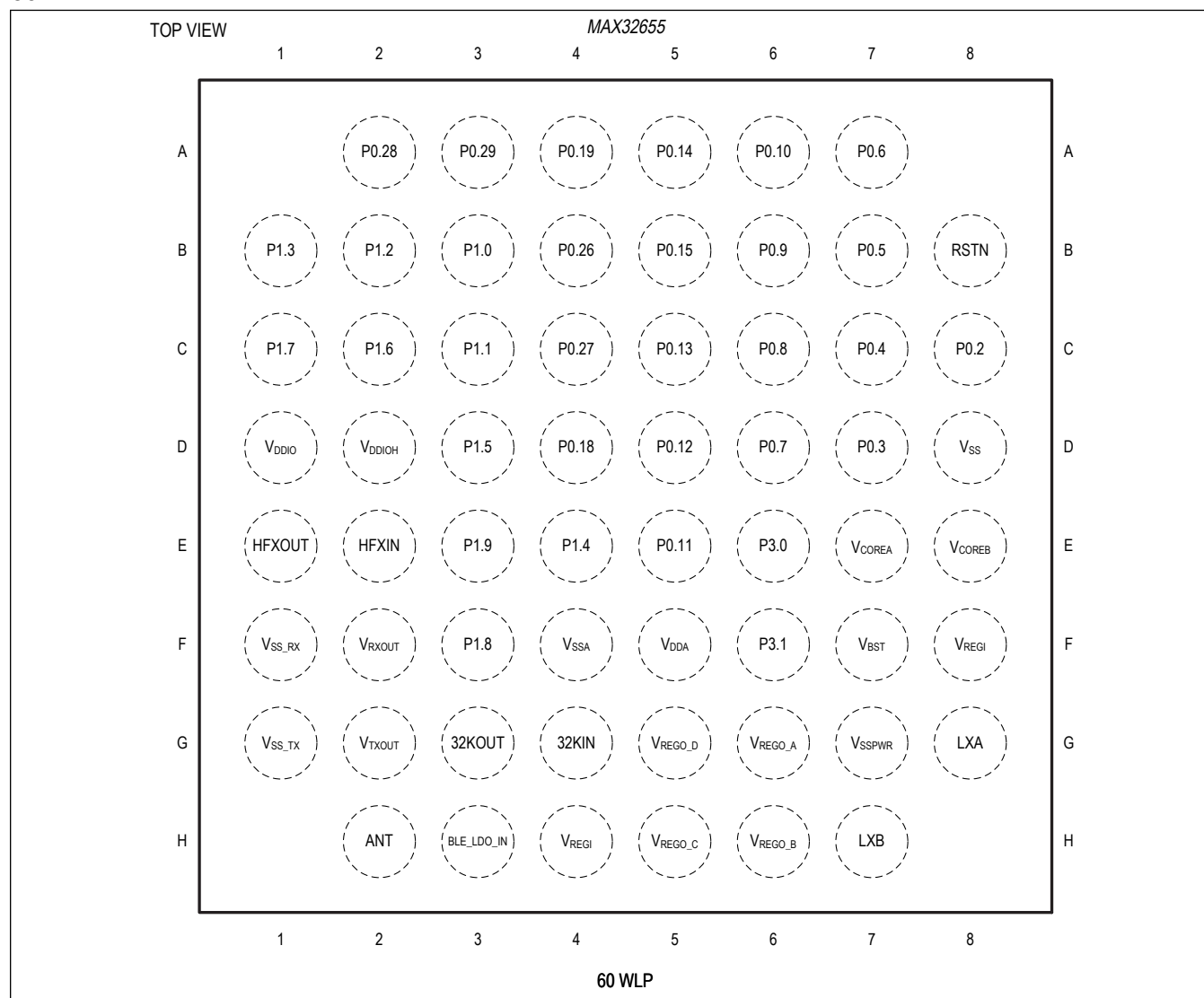
| PIN | NAME  | FUNCTION MODE            |                      |                      | FUNCTION                                                                                          |
|-----|-------|--------------------------|----------------------|----------------------|---------------------------------------------------------------------------------------------------|
|     |       | Primary Signal (Default) | Alternate Function 1 | Alternate Function 2 |                                                                                                   |
| J1  | P0.25 | P0.25                    | SPI1_SDIO3           | TMR2B_IOB            | SPI1 Data 3; Timer 2 I/O Upper 16 Bits Port Map B                                                 |
| H1  | P0.26 | P0.26                    | TMR2A_IOA            | SPI1_SS1             | Timer 2 I/O 32 Bits or Lower 16 Bits Port Map A; SPI1 Slave Select 1                              |
| H2  | P0.27 | P0.27                    | TMR2A_IOB            | SPI1_SS2             | Timer 2 I/O Upper 16 Bits Port Map A; SPI1 Slave Select 2                                         |
| G1  | P0.28 | P0.28                    | SWDIO                | —                    | Serial Wire Debug Data I/O                                                                        |
| G2  | P0.29 | P0.29                    | SWCLK                | —                    | Serial Wire Debug Clock                                                                           |
| F1  | P0.30 | P0.30                    | I2C2_SCL             | UART2B_CTS           | I2C2 Clock; UART2 Clear to Send Port Map B                                                        |
| F4  | P0.31 | P0.31                    | I2C2_SDA             | UART2B_RTS           | I2C2 Serial Data; UART2 Request to Send Port Map B                                                |
| F3  | P1.0  | P1.0                     | UART2A_RX            | RV_TCK               | UART2 Receive Port Map A; 32-Bit RISC-V Test Port Clock                                           |
| F2  | P1.1  | P1.1                     | UART2A_TX            | RV_TMS               | UART2 Transmit Port Map A; 32-Bit RISC-V Test Port Select                                         |
| D5  | P1.2  | P1.2                     | I2S_SCK              | RV_TDI               | I2S Bit Clock; 32-Bit RISC-V Test Port Data Input                                                 |
| E4  | P1.3  | P1.3                     | I2S_WS               | RV_TDO               | I2S Left/Right Clock; 32-Bit RISC-V Test Port Data Output                                         |
| E1  | P1.4  | P1.4                     | I2S_SDI              | TMR3B_IOA            | I2S Serial Data Input; Timer 3 I/O 32 Bits or Lower 16 Bits Port Map B                            |
| E3  | P1.5  | P1.5                     | I2S_SDO              | TMR3B_IOB            | I2S Serial Data Output; Timer 3 I/O Upper 16 Bits Port Map B                                      |
| E2  | P1.6  | P1.6                     | TMR3A_IOA            | BLE_ANT_CTR L2       | Timer 3 I/O 32 Bits or Lower 16 Bits Port Map A; Bluetooth Antenna Control Line 2                 |
| D4  | P1.7  | P1.7                     | TMR3A_IOB            | BLE_ANT_CTR L3       | Timer 3 I/O Upper 16 Bits Port Map A; Bluetooth Antenna Control Line 3                            |
| D2  | P1.8  | P1.8                     | BLE_ANT_CTR L0       | RXEVO                | Bluetooth Antenna Control Line 0; CM4 Rx Event Input                                              |
| D3  | P1.9  | P1.9                     | BLE_ANT_CTR L1       | TXEVO                | Bluetooth Antenna Control Line 1; CM4 Tx Event Output                                             |
| C4  | P2.0  | P2.0                     | AIN0/AIN0N           | —                    | Analog-to-Digital Converter Input 0/Comparator 0 Negative Input                                   |
| C5  | P2.1  | P2.1                     | AIN1/AIN0P           | —                    | Analog-to-Digital Converter Input 1/Comparator 0 Positive Input                                   |
| D8  | P2.2  | P2.2                     | AIN2/AIN1N           | —                    | Analog-to-Digital Converter Input 2/Comparator 1 Negative Input                                   |
| E8  | P2.3  | P2.3                     | AIN3/AIN1P           | —                    | Analog-to-Digital Converter Input 3/Comparator 1 Positive Input                                   |
| C7  | P2.4  | P2.4                     | AIN4/AIN2N           | LPTMR0B_IOA          | Analog-to-Digital Converter Input 4/Comparator 2 Negative Input; Low-Power Timer 0 I/O Port Map B |
| D7  | P2.5  | P2.5                     | AIN5/AIN2P           | LPTMR1B_IOA          | Analog-to-Digital Converter Input 5/Comparator 2 Positive Input; Low-Power Timer 1 I/O Port Map B |

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| PIN                   | NAME | FUNCTION MODE               |                           |                         | FUNCTION                                                                                                                                              |
|-----------------------|------|-----------------------------|---------------------------|-------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
|                       |      | Primary Signal<br>(Default) | Alternate<br>Function 1   | Alternate<br>Function 2 |                                                                                                                                                       |
| C6                    | P2.6 | P2.6                        | LPTMR0_CLK/<br>AIN6/AIN3N | LPUARTB_RX              | Low-Power Timer 0 External Clock Input/<br>Analog-to-Digital Converter Input 6/Comparator<br>3 Negative Input; Low-Power UART 0 Receive<br>Port Map B |
| D6                    | P2.7 | P2.7                        | LPTMR1_CLK/<br>AIN7/AIN3P | LPUARTB_TX              | Low-Power Timer 1 External Clock Input/<br>Analog-to-Digital Converter Input 7/Comparator<br>3 Positive Input; Low-Power UART Transmit<br>Port Map B  |
| E5                    | P3.0 | P3.0                        | PDOWN                     | WAKEUP                  | Power-Down Output; Wakeup Input. This device<br>pin can only be powered by $V_{DDIOH}$ .                                                              |
| E6                    | P3.1 | P3.1                        | SQWOUT                    | WAKEUP                  | Square-Wave Output; Wakeup Input. This<br>device pin can only be powered by $V_{DDIOH}$ .                                                             |
| <b>ANTENNA OUTPUT</b> |      |                             |                           |                         |                                                                                                                                                       |
| A1                    | ANT  | —                           | —                         | —                       | Antenna for Bluetooth Radio. Attach the single-<br>ended, unbalanced Bluetooth radio antenna.                                                         |

## Pin Configuration

## 60 WLP



## Pin Descriptions – 60 WLP

| PIN                                                                                                    | NAME                | FUNCTION MODE            |                      |                      | FUNCTION                                                                                                                                                                                                                                                                                                                                                                                                                     |
|--------------------------------------------------------------------------------------------------------|---------------------|--------------------------|----------------------|----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                                                                        |                     | Primary Signal (Default) | Alternate Function 1 | Alternate Function 2 |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| POWER (See the <a href="#">Applications Information</a> section for bypass capacitor recommendations.) |                     |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| F8, H4                                                                                                 | V <sub>REGI</sub>   | —                        | —                    | —                    | Battery Power Supply for the SIMO Switch-Mode Power Supply (SMPS). Bypass device pin H4 with 2 x 47µF capacitors placed as close as possible to the device pin H4 and V <sub>SSPWR</sub> pins for applications using a coin cell as the battery. See <a href="#">Bypass Capacitors</a> for more information. If power to the device is cycled, the voltage applied to this device pin must reach V <sub>REGI</sub> (rising). |
| H3                                                                                                     | BLE_LDO_IN          | —                        | —                    | —                    | Bluetooth LDO Input. Bypass BLE_LDO_IN with a 100nF capacitor to V <sub>SS</sub> placed as close as possible to the BLE_LDO_IN device pin.                                                                                                                                                                                                                                                                                   |
| F5                                                                                                     | V <sub>DDA</sub>    | —                        | —                    | —                    | 1.8V Analog Power Supply                                                                                                                                                                                                                                                                                                                                                                                                     |
| E7                                                                                                     | V <sub>COREA</sub>  | —                        | —                    | —                    | Digital Core Supply Voltage A                                                                                                                                                                                                                                                                                                                                                                                                |
| E8                                                                                                     | V <sub>COREB</sub>  | —                        | —                    | —                    | Digital Core Supply Voltage B                                                                                                                                                                                                                                                                                                                                                                                                |
| F2                                                                                                     | V <sub>RXOUT</sub>  | —                        | —                    | —                    | Radio Receiver Supply Voltage Output. Bypass this pin to V <sub>SS_RX</sub> with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                                                                                                               |
| G2                                                                                                     | V <sub>TXOUT</sub>  | —                        | —                    | —                    | Radio Transmitter Supply Voltage Output. Bypass this pin to V <sub>SS_TX</sub> with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                                                                                                            |
| F7                                                                                                     | V <sub>BST</sub>    | —                        | —                    | —                    | Boosted Supply Voltage for the Gate Drive of High-Side Switches. Bypass V <sub>BST</sub> to LXB with a 3.3nF capacitor.                                                                                                                                                                                                                                                                                                      |
| G6                                                                                                     | V <sub>REGO_A</sub> | —                        | —                    | —                    | Buck Converter A Voltage Output. Bypass V <sub>REGO_A</sub> with a 22µF capacitor to V <sub>SS</sub> placed as close as possible to the V <sub>REGO_A</sub> device pin. This capacitor should be placed on the PCB trace between the V <sub>REGO_A</sub> device pin and the V <sub>DDA</sub> device pin.                                                                                                                     |
| H6                                                                                                     | V <sub>REGO_B</sub> | —                        | —                    | —                    | Buck Converter B Voltage Output. Bypass V <sub>REGO_B</sub> with a 22µF capacitor to V <sub>SS</sub> placed as close as possible to the V <sub>REGO_B</sub> device pin. This capacitor should be placed on the PCB trace between the V <sub>REGO_B</sub> device pin and the closest V <sub>COREB</sub> device pin.                                                                                                           |
| H5                                                                                                     | V <sub>REGO_C</sub> | —                        | —                    | —                    | Buck Converter C Voltage Output. Bypass V <sub>REGO_C</sub> with a 22µF capacitor to V <sub>SS</sub> placed as close as possible to the V <sub>REGO_C</sub> device pin. This capacitor should be placed on the PCB trace between the V <sub>REGO_C</sub> device pin and the closest V <sub>COREA</sub> device pin.                                                                                                           |

**60 WLP**

| PIN                      | NAME    | FUNCTION MODE            |                      |                      | FUNCTION                                                                                                                                                                                                                                                                                                                                     |
|--------------------------|---------|--------------------------|----------------------|----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                          |         | Primary Signal (Default) | Alternate Function 1 | Alternate Function 2 |                                                                                                                                                                                                                                                                                                                                              |
| G5                       | VREGO_D | —                        | —                    | —                    | Buck Converter D Voltage Output. Bypass VREGO_D with a 22µF capacitor to VSS placed as close as possible to the VREGO_D device pin. This capacitor should be placed on the PCB trace between the VREGO_D device pin and the BLE_LDO_IN device pin.                                                                                           |
| D1                       | VDDIO   | —                        | —                    | —                    | GPIO Supply Voltage. Bypass this pin to VSS with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                                                               |
| D2                       | VDDIOH  | —                        | —                    | —                    | GPIO Supply Voltage, High. $V_{DDIOH} \geq V_{DDIO}$ . Bypass this pin to VSS with a 1.0µF capacitor placed as close as possible to the package.                                                                                                                                                                                             |
| D8                       | VSS     | —                        | —                    | —                    | Digital Ground                                                                                                                                                                                                                                                                                                                               |
| F4                       | VSSA    | —                        | —                    | —                    | Analog Ground                                                                                                                                                                                                                                                                                                                                |
| G7                       | VSSPWR  | —                        | —                    | —                    | Ground for the SIMO SMPS. This device pin is the return path for VREGI device pins C6 and C9.                                                                                                                                                                                                                                                |
| F1                       | VSS_RX  | —                        | —                    | —                    | Bluetooth Receiver Ground                                                                                                                                                                                                                                                                                                                    |
| G1                       | VSS_TX  | —                        | —                    | —                    | Bluetooth Transmitter Ground                                                                                                                                                                                                                                                                                                                 |
| G8                       | LXA     | —                        | —                    | —                    | Switching Inductor Input A. Connect a 2.2µH inductor between LXA and LXB.                                                                                                                                                                                                                                                                    |
| H7                       | LXB     | —                        | —                    | —                    | Switching Inductor Input B. Connect a 2.2µH inductor between LXA and LXB.                                                                                                                                                                                                                                                                    |
| <b>RESET AND CONTROL</b> |         |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                              |
| B8                       | RSTN    | —                        | —                    | —                    | Active-Low, External System Reset Input. The device remains in reset while this pin is in its active state. When the pin transitions to its inactive state, the device performs a POR (resetting all logic on all supplies except for real-time clock circuitry) and begins execution. This pin has an internal pullup to the VDDIOH supply. |
| <b>CLOCK</b>             |         |                          |                      |                      |                                                                                                                                                                                                                                                                                                                                              |
| G3                       | 32KOUT  | —                        | —                    | —                    | 32kHz Crystal Oscillator Output                                                                                                                                                                                                                                                                                                              |
| G4                       | 32KIN   | —                        | —                    | —                    | 32kHz Crystal Oscillator Input. Connect a 32kHz crystal between 32KIN and 32KOUT for RTC operation. Optionally, this pin can be configured as the input for an external CMOS-level clock source.                                                                                                                                             |
| E1                       | HFXOUT  | —                        | —                    | —                    | 32MHz Crystal Oscillator Output                                                                                                                                                                                                                                                                                                              |
| E2                       | HFXIN   | —                        | —                    | —                    | 32MHz Crystal Oscillator Input. Connect a 32MHz crystal between HFXIN and HFXOUT for Bluetooth operation. Optionally, this pin can be configured as the input for an external CMOS-level clock source.                                                                                                                                       |

## 60 WLP

| PIN                                                                                                                              | NAME  | FUNCTION MODE            |                       |                      | FUNCTION                                                                                                 |
|----------------------------------------------------------------------------------------------------------------------------------|-------|--------------------------|-----------------------|----------------------|----------------------------------------------------------------------------------------------------------|
|                                                                                                                                  |       | Primary Signal (Default) | Alternate Function 1  | Alternate Function 2 |                                                                                                          |
| GPIO AND ALTERNATE FUNCTION (See the <a href="#">Applications Information</a> section for GPIO and Alternate Function Matrices.) |       |                          |                       |                      |                                                                                                          |
| C8                                                                                                                               | P0.2  | P0.2                     | TMR0A_IOA             | UART0B_CTS           | Timer 0 I/O 32 Bits or Lower 16 Bits Port Map A; UART0 Clear to Send Port Map B                          |
| D7                                                                                                                               | P0.3  | P0.3                     | EXT_CLK/<br>TMR0A_IOB | UART0B_RTS           | External Clock for Use as SYS_OSC/Timer 0 I/O Upper 16 Bits Port Map A; UART0 Request to Send Port Map B |
| C7                                                                                                                               | P0.4  | P0.4                     | SPI0_SS0              | TMR0B_IOAN           | SPI0 Slave Select 0; Timer 0 Inverted Output Port Map B                                                  |
| B7                                                                                                                               | P0.5  | P0.5                     | SPI0_MOSI             | TMR0B_IOBN           | SP0 Master Out Slave In Serial Data 0; 32-Bit Timer 0 Inverted Output Upper 16 Bits Port Map B           |
| A7                                                                                                                               | P0.6  | P0.6                     | SPI0_MISO             | OWM_IO               | SPI0 Master In Slave Out Serial Data 1; 1-Wire Master Data I/O                                           |
| D6                                                                                                                               | P0.7  | P0.7                     | SPI0_SCK              | OWM_PE               | SPI0 Clock; 1-Wire Master Pullup Enable Output                                                           |
| C6                                                                                                                               | P0.8  | P0.8                     | SPI0_SDIO2            | TMR0B_IOA            | SPI0 Data 2 I/O; Timer 0 I/O 32 Bits or Lower 16 Bits Port Map B                                         |
| B6                                                                                                                               | P0.9  | P0.9                     | SPI0_SDIO3            | TMR0B_IOB            | SPI0 Data 3 I/O; Timer 0 I/O Upper 16 Bits Port Map B                                                    |
| A6                                                                                                                               | P0.10 | P0.10                    | I2C0_SCL              | SPI0_SS2             | I2C0 Clock; SPI0 Slave Select 2                                                                          |
| E5                                                                                                                               | P0.11 | P0.11                    | I2C0_SDA              | SPI0_SS1             | I2C0 Serial Data; SPI0 Slave Select 1                                                                    |
| D5                                                                                                                               | P0.12 | P0.12                    | UART1A_RX             | TMR1B_IOAN           | UART1 Receive Port Map A; Timer 1 Inverted Output Port Map B                                             |
| C5                                                                                                                               | P0.13 | P0.13                    | UART1A_TX             | TMR1B_IOBN           | UART1 Transmit Port Map A; Timer 1 Inverted Output Upper 16 Bits Port Map B                              |
| A5                                                                                                                               | P0.14 | P0.14                    | TMR1A_IOA             | UART1B_CTS           | Timer 1 I/O 32 Bits or Lower 16 Bits Port Map A; UART1 Clear to Send Port Map B                          |
| B5                                                                                                                               | P0.15 | P0.15                    | TMR1A_IOB             | UART1B_RTS           | Timer 1 I/O Upper 16 Bits Port Map A; UART1 Request to Send Port Map B                                   |
| D4                                                                                                                               | P0.18 | P0.18                    | PT0                   | OWM_IO               | Pulse Train 0; 1-Wire Master Data I/O                                                                    |
| A4                                                                                                                               | P0.19 | P0.19                    | PT1                   | OWM_PE               | Pulse Train 1; 1-Wire Master Pullup Enable Output                                                        |
| B4                                                                                                                               | P0.26 | P0.26                    | TMR2A_IOA             | SPI1_SS1             | Timer 2 I/O 32 Bits or Lower 16 Bits Port Map A; SPI1 Slave Select 1                                     |
| C4                                                                                                                               | P0.27 | P0.27                    | TMR2A_IOB             | SPI1_SS2             | Timer 2 I/O Upper 16 Bits Port Map A; SPI1 Slave Select 2                                                |
| A2                                                                                                                               | P0.28 | P0.28                    | SWDIO                 | —                    | Serial Wire Debug Data I/O                                                                               |
| A3                                                                                                                               | P0.29 | P0.29                    | SWCLK                 | —                    | Serial Wire Debug Clock                                                                                  |
| B3                                                                                                                               | P1.0  | P1.0                     | UART2A_RX             | RV_TCK               | UART2 Receive Port Map A; 32-Bit RISC-V Test Port Clock                                                  |
| C3                                                                                                                               | P1.1  | P1.1                     | UART2A_TX             | RV_TMS               | UART2 Transmit Port Map A; 32-Bit RISC-V Test Port Select                                                |
| B2                                                                                                                               | P1.2  | P1.2                     | I2S_SCK               | RV_TDI               | I2S Bit Clock; 32-Bit RISC-V Test Port Data Input                                                        |

**60 WLP**

| PIN                   | NAME | FUNCTION MODE            |                      |                      | FUNCTION                                                                                      |
|-----------------------|------|--------------------------|----------------------|----------------------|-----------------------------------------------------------------------------------------------|
|                       |      | Primary Signal (Default) | Alternate Function 1 | Alternate Function 2 |                                                                                               |
| B1                    | P1.3 | P1.3                     | I2S_WS               | RV_TDO               | I <sup>2</sup> S Left/Right Clock; 32-Bit RISC-V Test Port Data Output                        |
| E4                    | P1.4 | P1.4                     | I2S_SDI              | TMR3B_IOA            | I <sup>2</sup> S Serial Data Input; Timer 3 I/O 32 Bits or Lower 16 Bits Port Map B           |
| D3                    | P1.5 | P1.5                     | I2S_SDO              | TMR3B_IOB            | I <sup>2</sup> S Serial Data Output; Timer 3 I/O Upper 16 Bits Port Map B                     |
| C2                    | P1.6 | P1.6                     | TMR3A_IOA            | BLE_ANT_CTR_L2       | Timer 3 I/O 32 Bits or Lower 16 Bits Port Map A; Bluetooth Antenna Control Line 2             |
| C1                    | P1.7 | P1.7                     | TMR3A_IOB            | BLE_ANT_CTR_L3       | Timer 3 I/O Upper 16 Bits Port Map A; Bluetooth Antenna Control Line 3                        |
| F3                    | P1.8 | P1.8                     | BLE_ANT_CTR_L0       | RXEVO                | Bluetooth Antenna Control Line 0; CM4 Rx Event Input                                          |
| E3                    | P1.9 | P1.9                     | BLE_ANT_CTR_L1       | TXEVO                | Bluetooth Antenna Control Line 1; CM4 Tx Event Output                                         |
| E6                    | P3.0 | P3.0                     | PDOWN                | WAKEUP               | Power-Down Output; Wakeup Input. This device pin can only be powered by V <sub>DDIOH</sub> .  |
| F6                    | P3.1 | P3.1                     | SQWOUT               | WAKEUP               | Square-Wave Output; Wakeup Input. This device pin can only be powered by V <sub>DDIOH</sub> . |
| <b>ANTENNA OUTPUT</b> |      |                          |                      |                      |                                                                                               |
| H2                    | ANT  | —                        | —                    | —                    | Antenna for Bluetooth Radio. Attach the single-ended, unbalanced Bluetooth radio antenna.     |

## Detailed Description

The MAX32655 MCU is an advanced system-on-chip featuring an Arm Cortex-M4F CPU for efficient computation of complex functions and algorithms qualified to operate at a temperature range of -40°C to +105°C. The SoC integrates power regulation and management with a SIMO buck regulator system. On board is the latest generation Bluetooth 5.2 LE radio, supporting LE Audio, AoA, and AoD for direction finding, long-range (coded), and high-throughput modes. The device offers large onboard memory with 512KB flash and 128KB SRAM, with optional error correction coding on one 32K SRAM bank. This 32KB bank can be optionally retained in BACKUP mode. An 8KB user OTP area is available, of which 8 bytes are retained, even during POWER DOWN mode. Many high-speed interfaces are supported on the device, including SPI, UART, and I<sup>2</sup>C serial interfaces, plus one I<sup>2</sup>S port for connecting to an audio codec. Additional low-power peripherals include flexible LPTIMER, LPUART, and analog comparators. An eight-input, 10-bit ADC is available to monitor analog input from external analog sources.

### Arm Cortex-M4 (CM4) with FPU Processor and RISC-V (RV32) Processor

The Arm Cortex-M4 with FPU processor is ideal for low-power system control. The architecture combines high-efficiency signal processing functionality with low power, low cost, and ease of use.

The Arm Cortex-M4 with FPU DSP supports single instruction multiple data (SIMD) path DSP extensions, providing:

- Four parallel 8-bit add/sub
- Floating-point single precision
- Two parallel 16-bit add/sub
- Two parallel MACs
- 32- or 64-bit accumulate
- Signed and unsigned data with or without saturation

The addition of 32-bit RISC-V processor (RV32) provides the system with ultra-low-power consumption signal processing.

## Memory

### Internal Flash Memory

512KB of internal flash memory provides nonvolatile storage of program and data memory.

### Internal SRAM

The internal 128KB SRAM provides low-power retention of application information in all power modes except POWER DOWN. The SRAM is divided into four banks. SRAM0 and SRAM1 are both 32KB, SRAM2 is 48KB, and SRAM3 is 16KB. SRAM2 and SRAM3 are accessible by the RV32 in LOW POWER mode. For enhanced system reliability, SRAM0 (32KB) can be configured with error correction coded (ECC), single error correction-double error detection (SED-DED). This data retention feature is optional and configurable. This granularity allows the application to minimize its power consumption by only retaining the most essential data.

## Bluetooth 5.2

### Bluetooth 5.2 Low Energy Radio

Bluetooth 5.2 LE is the latest version of the Bluetooth wireless communication standard. It is used for wireless headphones and other audio hardware, as well as for communication between various smart home and internet of things (IoT) devices. Bluetooth LE communications operate in the unlicensed 2.4GHz industrial-scientific-medical (ISM) band. A frequency-hopping transceiver is used to combat interference and fading. The system operates in the 2.4GHz ISM band at 2400MHz to 2483.5MHz. It uses 40 RF channels. These RF channels have center frequencies  $2402 + k \times 2\text{MHz}$ , where  $k = 0, \dots, 39$ . The Bluetooth stack runs on RV32 so that the CM4 can be freed to run application code. The features of the radio include the following:

- Higher transmit power up to +4.5dbm
- 1Mbps, 2Mbps, and long-range coded (125kbps and 500kbps)

- Increased broadcast capability
  - Advertising packet up to 255 bytes
- On-chip matching network to the antenna
- Antenna control outputs
- Direction finding with AoA and AoD
- Provides hardware on-the-fly encryption and decryption for lower power consumption
- Low transmit current of 4.17mA at 0dbm at 3.3V
- Low receive current of 4.0mA at 3.3V
- Supports mesh networking
- Supports high-quality audio streaming (isochronous)

### Bluetooth 5.2 Software Stack

A Bluetooth 5.2 software stack is available for application developers to quickly add support to devices. The Arm Cordio®-B50 software stack is provided in library form and provides application developers access to Bluetooth technology without validation and development of a software stack. The Cordio-B50 software stack interfaces to the Bluetooth link layer running on dedicated hardware. The dedicated hardware for the stack enables the ultimate in power management for IoT applications. Cordio-B50 features the following:

- C library for linking directly into an application development tool
- Change PHY support
  - Host selects the PHY it needs to use at any given time enabling long range or higher bandwidth only when required
    - Bluetooth LE 1M
    - Bluetooth LE Coded S = 2
    - Bluetooth LE Coded S = 8
    - Bluetooth LE 2M
- Bluetooth 5.2 advertising extension support for enabling next-generation Bluetooth beacons
  - Larger packets and advertising channel offloading
  - Packets up to 255 octets long
  - Advertising packet chaining
  - Advertising sets
  - Periodic advertising
  - High-duty cycle non-connectable advertising
  - Sample applications using standard profiles built on the Cordio-B50 software framework

### Comparators

The eight AIN[7:0] inputs can be configured as four pairs and deployed as four independent comparators with the following features:

- Comparison events can trigger interrupts
- Events can wake the CM4 from SLEEP, LOW POWER, MICRO POWER, STANDBY, or BACKUP operating modes
- Can be active in all power modes

See [Table 1](#) for details of instances of the comparators.

**Table 1. Comparator Instances**

| PACKAGE  |        | INSTANCE               |
|----------|--------|------------------------|
| 81 CTBGA | 60 WLP |                        |
| Yes      | No     | CMP0, CMP1, CMP2, CMP3 |

### Dynamic Voltage Scaling (DVS) Controller

The DVS controller works using the fixed high-speed oscillator and the  $V_{COREA}$  supply voltage to optimally operate the Arm core at the lowest practical voltage. The ability to adaptively adjust the voltage provides a significant reduction in dynamic power consumption.

The DVS controller provides the following features:

- DVS monitoring and adjustment functions
- Continuous monitoring with programmable monitor sample period
- Controlled transition to a programmable operating point
- Independent high and low operating limits for safe, bounded operation
- Independent high, center, and low operating range delay line monitors
- Programmable adjustment rate when an adjustment is required
- Single clock operation
- APB interface provides IP control and status access
- Interrupt capability during error

### Clocking Scheme

Multiple clock sources can be selected as the system clock:

- Internal primary oscillator (IPO) at a nominal frequency of 100MHz
- Internal secondary oscillator (ISO) at a nominal frequency of 60MHz
- Configurable internal nano-ring oscillator (INRO) at 8kHz, 16kHz, or 30kHz
- External RTC oscillator at 32.768kHz (ERTCO)—external crystal required
- Internal baud rate oscillator at 7.3728MHz (IBRO)
- External square-wave clock up to 80MHz
- External RF oscillator at 32MHz (ERFO)—external crystal required

There are multiple external clock inputs:

- LPTMR0 and LPTMR1 can be clocked from unique external sources (81 CTBGA only).
- SYS\_CLK can be derived from an external source.

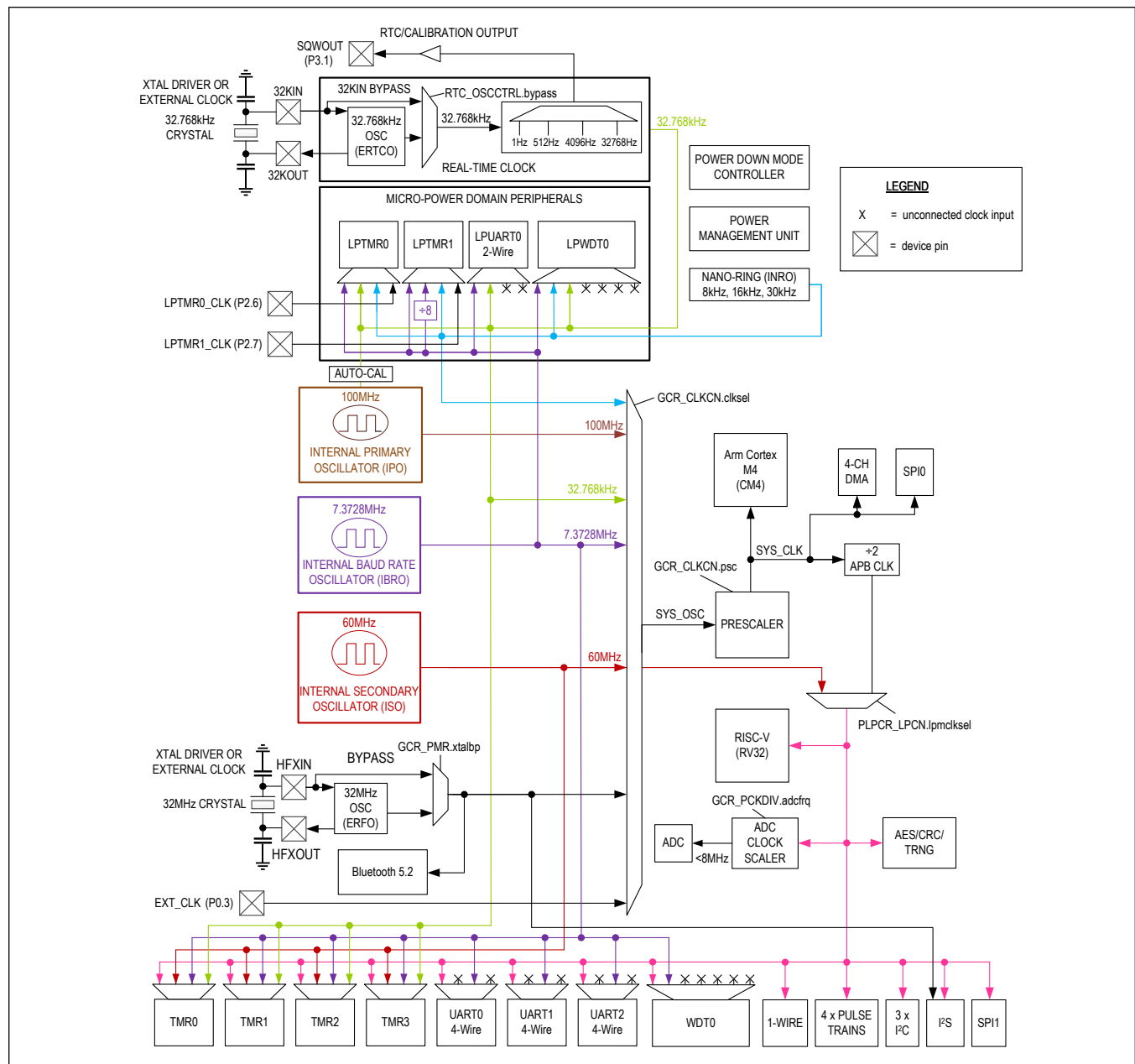


Figure 6. 81 CTBGA Clocking Scheme Diagram

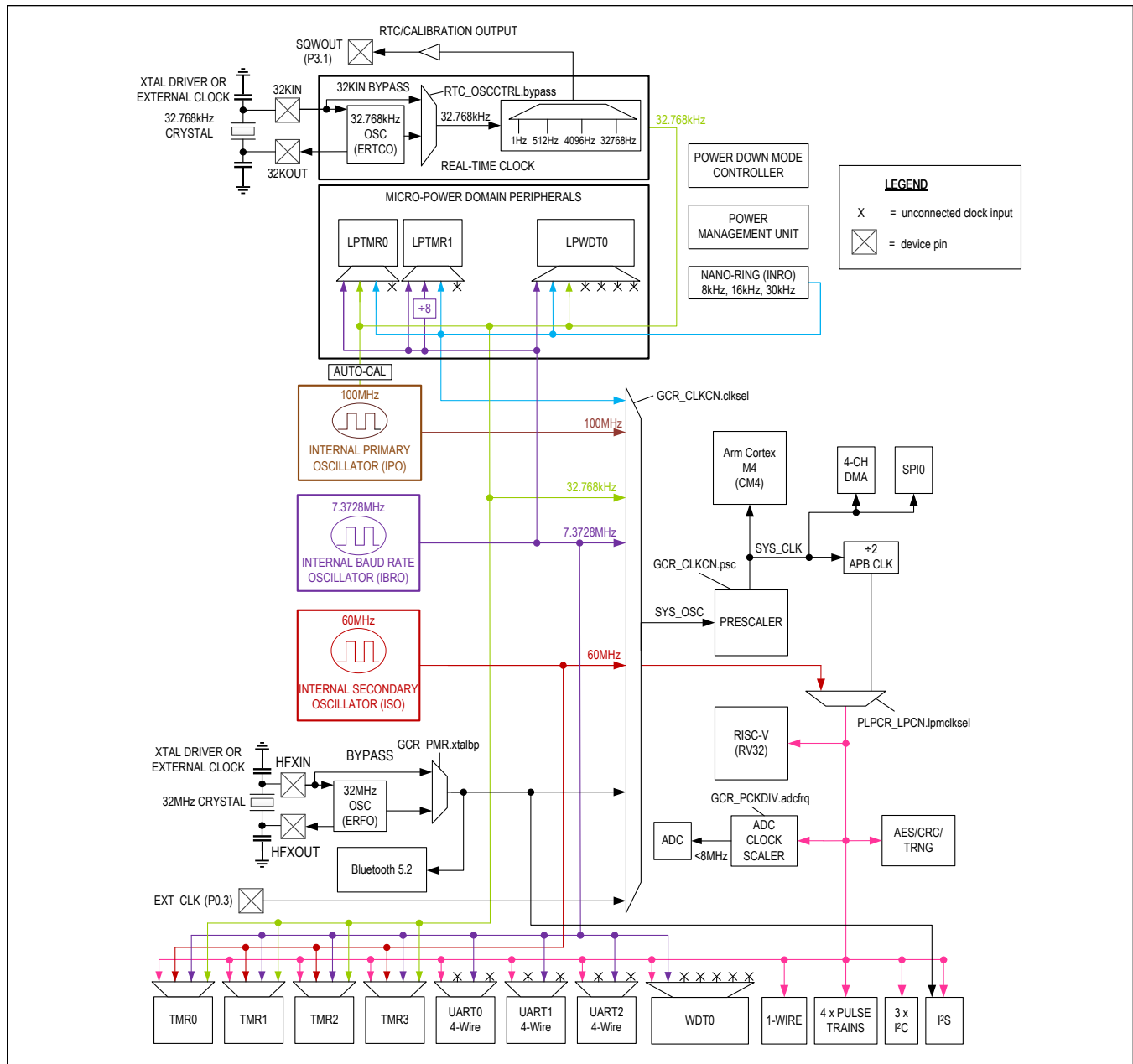


Figure 7. 60 WLP Clocking Scheme Diagram

### General-Purpose I/O (GPIO) and Special Function Pins

Most GPIO pins share both a firmware-controlled I/O function and one or more alternate functions associated with peripheral modules. Pins can be individually enabled for GPIO or peripheral special function use. Configuring a pin as a special function usually supersedes its use as a firmware-controlled I/O. Although this multiplexing between peripheral and GPIO functions is usually static, it can also be done dynamically. The electrical characteristics of a GPIO pin are identical whether the pin is configured as an I/O or special function, except where explicitly noted in the Electrical Characteristics tables.

In GPIO mode, pins are logically divided into ports of 32 pins. Each pin of a port has an interrupt function that can be

independently enabled, and configured as a level- or edge-sensitive interrupt. All GPIOs of a given port share the same interrupt vector.

When configured as GPIO, all features can be independently enabled or disabled on a per-pin basis. The following features are provided:

- Configurable as input, output, bidirectional, or high impedance
- Optional internal pullup resistor or internal pulldown resistor when configured as input
- Exit from low-power modes on rising or falling edge
- Selectable standard- or high-drive modes

The MAX32655 provides up to 52 GPIO pins. Caution is needed since Port 3 (P3.0 and P3.1 device pins) is configured in a different manner from the above description.

**Analog-to-Digital Converter (ADC)**

The 10-bit sigma-delta ( $\Sigma\Delta$ ) ADC provides an integrated reference generator and a single-ended input multiplexer. The multiplexer selects an input channel from one of the eight external analog input signals (AIN0–AIN7) or the internal power supply inputs.

The reference for the ADC can be:

- Internal 1.22V bandgap
- V<sub>SSA</sub> analog supply

An optional feature allows samples captured by the ADC to be automatically compared against user-programmable high and low limits. Up to four channel limit pairs can be configured in this way. The comparison allows the ADC to trigger an interrupt (and potentially wake the CPU from a power mode) when a captured sample goes outside the preprogrammed limit range. Since this comparison is performed directly by the sample limit monitors, it can be performed even while the CPU is in SLEEP, LOW POWER or MICRO POWER mode. The eight AIN[7:0] inputs can be configured as four pairs and deployed as four independent comparators.

The ADC measures the following voltages:

- AIN[7:0] up to 3.3V
- V<sub>REGI</sub>
- V<sub>COREA</sub>
- V<sub>COREB</sub>
- V<sub>DDIOH</sub>
- V<sub>DDIO</sub>
- V<sub>TXOUT</sub>
- V<sub>RXOUT</sub>
- V<sub>DDA</sub>

See [Table 2](#) for details of instances of the ADC.

**Table 2. ADC Instances**

| PACKAGE  |        | INSTANCE |
|----------|--------|----------|
| 81 CTBGA | 60 WLP |          |
| Yes      | No     | ADC0     |

**Single-Inductor Multiple-Output (SIMO) Switch-Mode Power Supply (SMPS)**

The SIMO SMPS built into the device provides a monolithic power supply architecture for operation from a single lithium cell. The SIMO provides four buck regulator outputs that are voltage programmable. This architecture optimizes power consumption efficiency of the device and minimizes the bill of materials for the circuit design since only a single inductor/capacitor pair is required.

**Power Management**

**Power Management Unit (PMU)**

The PMU provides high-performance operation while minimizing power consumption. It exercises intelligent, precise control of power distribution to the CPUs and peripheral circuitry.

The PMU provides the following features:

- User-configurable system clock
- Automatic enabling and disabling of crystal oscillators based on power mode
- Multiple power domains
- Fast wake-up of powered-down peripherals when activity detected

**ACTIVE Mode**

In this mode, the CM4 and the RV32 can execute application code and all digital and analog peripherals are available on demand. Dynamic clocking disables peripherals not in use, providing the optimal mix of high performance and low power consumption. The CM4 has access to all system SRAM. The RV32 has access to SRAM2 and SRAM3. Both the CM4 and the RV32 can execute from internal flash simultaneously. SRAM3 can be configured as an instruction cache for the RV32.

**SLEEP Mode**

This mode consumes less power, but wakes faster because the clocks can optionally be enabled.

The device status is as follows:

- CM4 is asleep
- RV32 is asleep
- Peripherals are on
- Standard DMA is available for optional use

**LOW POWER Mode (LPM)**

This mode is suitable for running the RV32 processor to collect and move data from enabled peripherals.

The device status is as follows:

- The CM4, SRAM0, and SRAM1 are in state retention.
- The RV32 can access the SPI, all UARTS, all timers, I<sup>2</sup>C, 1-Wire, pulse train engines, I<sup>2</sup>S, CRC, AES, TRNG, PCIF, and comparators, as well as SRAM2 and SRAM3. SRAM3 can be configured to operate as RV32 instruction cache
- The transition from LOW POWER mode to ACTIVE mode is faster than the transition from BACKUP mode because system initialization is not required.
- The DMA can access flash.
- IPO can be optionally powered down.
- The following oscillators are enabled:
  - IBRO
  - ERTCO
  - INRO
  - ISO
  - ERFO

**MICRO POWER Mode (μPM)**

This mode is used for extremely low power consumption while using a minimal set of peripherals to provide wakeup capability.

The device status is as follows:

- Both CM4 and RV32 are state retained. (System state and all SRAM is retained.)
- The GPIO pins retain their state.
- All non-MICRO POWER peripherals are state retained.
- IBRO can be optionally powered down.
- The following oscillators are powered down:

- IPO
- ISO
- ERFO
- The following oscillators are enabled:
  - IBRO
  - ERTCO
  - INRO
- The following MICRO POWER mode peripherals are available for use to wake up the device:
  - LPUART0, LPUART1
  - WWDT1
  - All four low-power analog comparators

### STANDBY Mode

This mode is used to maintain the system operation while keeping time with the RTC.

The device status is as follows:

- Both CM4 and RV32 are state retained. (System state and all SRAM is retained.)
- The GPIO pins retain their state.
- RTC is on.
- All peripherals are state retained.
- The following oscillators are powered down:
  - IPO
  - ISO
  - IBRO
  - ERFO
- The following oscillators are enabled:
  - ERTCO
  - INRO

### BACKUP Mode

This mode is used maintain the system RAM. The device status is as follows:

- CM4 and RV32 are powered off.
- SRAM0, SRAM1, SRAM2 and SRAM3 can be configured to be state retained as per [Table 3](#).
- All peripherals are powered off.
- The GPIO pins retain their state.
- RTC is on.
- The following oscillators are powered down:
  - IPO
  - ISO
  - IBRO
  - INRO
  - ERFO
- The following oscillators are enabled:
  - ERTCO

**Table 3. BACKUP Mode SRAM Retention**

| RAM BLOCK | RAM SIZE   |
|-----------|------------|
| SRAM0     | 32KB + ECC |
| SRAM1     | 32KB       |
| SRAM2     | 48KB       |

**Table 3. BACKUP Mode SRAM Retention (continued)**

|       |      |
|-------|------|
| SRAM3 | 16KB |
|-------|------|

**POWER DOWN Mode (PDM)**

This mode is used during product level distribution and storage.

The device status is as follows:

- The CM4 and RV32 are powered off.
- All peripherals and SRAM are powered down.
- All oscillators are powered down.
- 8 bytes of data are retained.
- Values in the flash are preserved.
- Voltage monitors are operational.

**Wake-Up Sources**

The sources of wake-up from the SLEEP, LOW POWER, MICRO POWER, STANDBY, BACKUP, and POWER DOWN operating modes are summarized in [Table 4](#).

**Table 4. Wake-Up Sources**

| OPERATING MODE    | WAKE-UP SOURCE                                                                                                                      |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------------|
| SLEEP             | Any enabled peripheral with interrupt capability; RSTN                                                                              |
| LOW POWER (LPM)   | SPI0, I <sup>2</sup> S, I <sup>2</sup> C, UARTs, timers, watchdog timers, wakeup timer, all comparators, RTC, GPIOs, RSTN, and RV32 |
| MICRO POWER (μPM) | All comparators, LPUART (where available), LPTMR1, LPTIMER2, LPWDT0, RTC, wakeup timer, GPIOs, and RSTN                             |
| STANDBY           | RTC, wakeup timer, GPIOs, CMP0 (where available), and RSTN                                                                          |
| BACKUP            | RTC, wakeup timer, GPIOs, CMP0 (where available), and RSTN                                                                          |
| POWER DOWN (PDM)  | P3.0, P3.1, and RSTN                                                                                                                |

**Real-Time Clock (RTC)**

An RTC keeps the time of day in absolute seconds. The 32-bit seconds register can count up to approximately 136 years and be translated to calendar format by application software.

The RTC provides a time-of-day alarm that is programmable to any future value between 1 second and 12 days. When configured for long intervals, the time-of-day alarm is usable as a power-saving timer, allowing the device to remain in an extremely low-power mode, but still awaken periodically to perform assigned tasks. A second independent 32-bit 1/4096 subsecond alarm is programmable with a tick resolution of 244μs. Both can be configured as recurring alarms. When enabled, either alarm can cause an interrupt or wake the device from most low-power modes.

The time base is generated by a 32.768kHz crystal or an external clock source that must meet the electrical/timing requirements in the [Electrical Characteristics](#) table.

The RTC calibration feature provides the ability for user software to compensate for minor variations in the RTC oscillator, crystal, temperature, and board layout. Enabling the SQWOUT alternate function outputs a timing signal derived from the RTC. External hardware can measure the frequency and adjust the RTC frequency in increments of ±127ppm with 1ppm resolution. Under most circumstances, the oscillator does not require any calibration.

**Programmable Timers****32-Bit Timer/Counter/PWM (TMR, LPTMR)**

General-purpose, 32-bit timers provide timing, capture/compare, or generation of pulse-width modulated (PWM) signals with minimal software interaction.

The timer provides the following features:

- 32-bit up/down autoreload
- Programmable prescaler
- PWM output generation
- Capture, compare, and capture/compare capability
- External pin multiplexed with GPIO for timer input, clock gating, or capture
- Timer output pin
- TMR0–TMR3 can be configured as two 16-bit general-purpose timers
- Timer interrupt

The MAX32655 provides six 32-bit timers (TMR0, TMR1, TMR2, TMR3, LPTMR0, and LPTMR1). LPTMR0 and LPTMR1 are capable of operation in the SLEEP, LOW POWER, and MICRO POWER modes.

I/O functionality is supported for all of the timers. Note that the function of a port can be multiplexed with other functions on the GPIO pins, so it might not be possible to use all the ports depending on the device configuration. See [Table 5](#) for individual timer features.

**Table 5. Timer Configuration Options**

| INSTANCE | REGISTER ACCESS NAME | SINGLE 32 BIT | DUAL 16 BIT | SINGLE 16 BIT | POWER MODE                            | CLOCK SOURCE |     |      |      |       |            |            |
|----------|----------------------|---------------|-------------|---------------|---------------------------------------|--------------|-----|------|------|-------|------------|------------|
|          |                      |               |             |               |                                       | PCLK         | ISO | IBRO | INRO | ERTCO | LPTMR0_CLK | LPTMR1_CLK |
| TMR0     | TMR0                 | Yes           | Yes         | No            | ACTIVE, SLEEP, LOW POWER              | Yes          | Yes | Yes  | No   | Yes   | No         | No         |
| TMR1     | TMR1                 | Yes           | Yes         | No            | ACTIVE, SLEEP, LOW POWER              | Yes          | Yes | Yes  | No   | Yes   | No         | No         |
| TMR2     | TMR2                 | Yes           | Yes         | No            | ACTIVE, SLEEP, LOW POWER              | Yes          | Yes | Yes  | No   | Yes   | No         | No         |
| TMR3     | TMR3                 | Yes           | Yes         | No            | ACTIVE, SLEEP, LOW POWER              | Yes          | Yes | Yes  | No   | Yes   | No         | No         |
| LPTMR0*  | TMR4                 | No            | No          | Yes           | ACTIVE, SLEEP, LOW POWER, MICRO POWER | No           | No  | Yes  | Yes  | Yes   | Yes        | No         |
| LPTMR1*  | TMR5                 | No            | No          | Yes           | ACTIVE, SLEEP, LOW POWER, MICRO POWER | No           | No  | Yes  | Yes  | Yes   | No         | Yes        |

\* Available as an internal timer only on the 60-WLP package. There is no external connection to this timer on the 60 WLP package.

### Watchdog Timer (WDT)

Microcontrollers are often used in harsh environments where electrical noise and electromagnetic interference (EMI) are abundant. Without proper safeguards, these hazards can disturb device operation and corrupt program execution. One of the most effective countermeasures is the windowed WDT, which detects runaway code or system unresponsiveness. The WDT is a 32-bit, free-running counter with a configurable prescaler. When enabled, the WDT must be periodically

reset by the application software. Failure to reset the WDT within the user-configurable timeout period indicates that the application software is not operating correctly and results in a WDT timeout. A WDT timeout can trigger an interrupt, system reset, or both. Either response forces the instruction pointer to a known good location before resuming instruction execution. The windowed timeout period feature provides more detailed monitoring of system operation, requiring the WDT to be reset within a specific window of time. See [Table 6](#) for individual timer features.

The MAX32655 provides two instances of the watchdog timer—WDT0 and LPWDT0.

**Table 6. Watchdog Timer Configuration Options**

| INSTANCE NAME | REGISTER ACCESS NAME | POWER MODE                                     | CLOCK SOURCE |      |      |       |
|---------------|----------------------|------------------------------------------------|--------------|------|------|-------|
|               |                      |                                                | PCLK         | IBRO | INRO | ERTCO |
| WDT0          | WDT0                 | ACTIVE,<br>SLEEP,<br>LOW POWER                 | Yes          | Yes  | No   | No    |
| LPWDT0        | WDT1                 | ACTIVE,<br>SLEEP,<br>LOW POWER,<br>MICRO POWER | No           | Yes  | Yes  | Yes   |

### Pulse Train Engine (PT)

Multiple, independent pulse train generators can provide either a square-wave or a repeating pattern from 2 to 32 bits in length. Any single pulse train generator or any desired group of pulse train generators can be synchronized at the bit level allowing for multibit patterns. Each pulse train generator is independently configurable.

The pulse train generators provide the following features:

- Independently enabled
- Safe enable and disable for pulse trains without bit banding
- Multiple pin configurations allow for flexible layout
- Pulse trains can be started/synchronized independently or as a group
- Frequency of each enabled pulse train generator is also set separately, based on a divide down (divide by 2, divide by 4, divide by 8, and so on) of the input pulse train module clock
- Input pulse train module clock can be optionally configured to be independent from the system AHB clock
- Multiple repetition options
  - Single shot (nonrepeating pattern of 2 to 32 bits)
  - Pattern repeats a user-configurable number of times or indefinitely
  - Termination of one pulse train loop count can restart one or more other pulse trains

The pulse train engine feature is an alternate function associated with a GPIO pin. In most cases, enabling the pulse train engine function supersedes the GPIO function.

See [Table 7](#) for details of instances of the pulse train peripheral.

**Table 7. Pulse Train Instances**

| PACKAGE  |        | INSTANCE |
|----------|--------|----------|
| 81 CTBGA | 60 WLP |          |
| Yes      | Yes    | PT0      |
| Yes      | Yes    | PT1      |
| Yes      | No     | PT2      |
| Yes      | No     | PT3      |

## Serial Peripherals

### I<sup>2</sup>C Interface (I2C)

The I<sup>2</sup>C interface is a bidirectional, two-wire serial bus that provides a medium-speed communications network. It can

operate as a one-to-one, one-to-many, or many-to-many communications medium. This interface supports standard-mode, fast-mode, fast-mode plus, and high-speed mode I<sup>2</sup>C speeds. It provides the following features:

- Master or slave mode operation
  - Supports up to 4 different slave addresses in slave mode
- Supports standard 7-bit addressing or 10-bit addressing
- RESTART condition
- Interactive receive mode (IRXM)
- Transmitter FIFO preloading
- Support for clock stretching to allow slower slave devices to operate on higher speed busses
- Multiple transfer rates
  - Standard mode: 100kbps
  - Fast mode: 400kbps
  - Fast mode plus: 1000kbps
  - High-speed mode: 3.4Mbps
- Internal filter to reject noise spikes
- Receiver FIFO depth of 8 bytes
- Transmitter FIFO depth of 8 bytes

See [Table 8](#) for details of the instances of the I<sup>2</sup>C peripheral.

**Table 8. I<sup>2</sup>C Instances**

| PACKAGE  |        | INSTANCE |
|----------|--------|----------|
| 81 CTBGA | 60 WLP |          |
| Yes      | Yes    | I2C0     |
| Yes      | No     | I2C1     |
| Yes      | No     | I2C2     |

### I<sup>2</sup>S Interface (I2S)

The I<sup>2</sup>S interface is a bidirectional, four-wire serial bus that provides serial communications for codecs and audio amplifiers compliant with the I<sup>2</sup>S Bus Specification, June 5, 1996. It provides the following features:

- Master and slave mode operation
- Support for 4 channels
- 8, 16, 24, and 32-bit frames
- Receive and transmit DMA support
- Wake-up on FIFO status (full/empty/threshold)
- Pulse density modulation support for the receive channel
- Word-select polarity control
- First-bit position selection
- Interrupts generated for FIFO status
- Receiver FIFO depth of 32 bytes
- Transmitter FIFO depth of 32 bytes

The MAX32655 provides one instance of the I<sup>2</sup>S peripheral (I2S0).

### Serial Peripheral Interface (SPI)

The SPI is a highly configurable, flexible, and efficient synchronous interface where multiple SPI devices can coexist on a single bus. The bus uses a single clock signal and multiple data signals, as well as one or more slave select lines to address only the intended target device. The SPI operates independently and requires minimal processor overhead.

The provided SPI peripherals can operate in either slave or master mode and provide the following features:

- SPI modes 0, 1, 2, or 3 for single-bit communication
- 3- or 4-wire mode for single-bit slave device communication
- Full-duplex operation in single-bit, 4-wire mode

- Dual and quad data modes supported
- Multiple slave selects on some instances
- Multimaster mode fault detection
- Programmable interface timing
- Programmable SCK frequency and duty cycle
- 32-byte transmit and receive FIFOs
- Slave select assertion and deassertion timing with respect to leading/trailing SCK edge

See [Table 9](#) for SPI configuration options.

**Table 9. SPI Configuration Options**

| PACKAGE  |        | INSTANCE | DATA                                       | SLAVE SELECT LINES | MAXIMUM FREQUENCY MASTER MODE (MHz) | MAXIMUM FREQUENCY SLAVE MODE (MHz) |
|----------|--------|----------|--------------------------------------------|--------------------|-------------------------------------|------------------------------------|
| 81 CTBGA | 60 WLP |          |                                            |                    |                                     |                                    |
| Yes      | Yes    | SPI0     | 3-wire, 4-wire, dual, or quad data support | 3                  | 50                                  | 50                                 |
| Yes      | No     | SPI1     | 3-wire, 4-wire, dual, or quad data support | 1                  | 25                                  | 50                                 |

## UART (UART, LPUART)

The universal asynchronous receiver-transmitter (UART, LPUART) interface supports full-duplex asynchronous communication with optional hardware flow control (HFC) modes to prevent data overruns. If HFC mode is enabled on a given port, the system uses two extra pins to implement the industry-standard request to send (RTS) and clear to send (CTS) flow control signaling. Each instance is individually programmable.

- 2-wire interface or 4-wire interface with flow control
- 8-byte send/receive FIFO
- Full-duplex operation for asynchronous data transfers
- Interrupts available for frame error, parity error, CTS, Rx FIFO overrun, and FIFO full/partially full conditions
- Automatic parity and frame error detection
- Independent baud-rate generator
- Programmable 9th-bit parity support
- Multidrop support
- Start/stop bit support
- Hardware flow control using RTS/CTS
- 12.5Mbps for UART maximum baud rate
- 1.85Mbps for LPUART maximum baud rate
- Two DMA channels can be connected (read and write FIFOs)
- Programmable word size (5 bits to 8 bits)

The MAX32655 provides four instances of the UART peripheral—UART0, UART1, UART2, and LPUART0. LPUART0 is capable of operation in the SLEEP, LOW POWER, and MICRO POWER modes. See [Table 10](#) for configuration options.

**Table 10. UART Configuration Options**

| PACKAGE  |        | INSTANCE NAME | REGISTER ACCESS NAME | HARDWARE FLOW CONTROL | POWER MODE               | CLOCK SOURCE |      |       |
|----------|--------|---------------|----------------------|-----------------------|--------------------------|--------------|------|-------|
| 81 CTBGA | 60 WLP |               |                      |                       |                          | PCLK         | IBRO | ERTCO |
| Yes      | No     | UART0         | UART0                | Yes                   | ACTIVE, SLEEP, LOW POWER | Yes          | Yes  | No    |
| Yes      | Yes    | UART1         | UART1                | Yes                   | ACTIVE, SLEEP, LOW POWER | Yes          | Yes  | No    |
| Yes      | Yes    | UART2         | UART2                | 81 CTBGA only         | ACTIVE, SLEEP, LOW POWER | Yes          | Yes  | No    |

**Table 10. UART Configuration Options (continued)**

|     |    |         |       |    |                                                |    |     |     |
|-----|----|---------|-------|----|------------------------------------------------|----|-----|-----|
| Yes | No | LPUART0 | UART3 | No | ACTIVE,<br>SLEEP,<br>LOW POWER,<br>MICRO POWER | No | Yes | Yes |
|-----|----|---------|-------|----|------------------------------------------------|----|-----|-----|

**1-Wire Master (OWM)**

Maxim's 1-Wire bus consists of one signal that carries data and also supplies power to the slave devices and a ground return. The bus master communicates serially with one or more slave devices through the bidirectional, multidrop 1-Wire bus. The single-contact serial interface is ideal for communication networks requiring minimal interconnection.

The provided 1-Wire master supports the following features:

- Single contact for control and operation
- Unique factory identifier for any 1-Wire device
- Multiple device capability on a single line

The OWM supports both standard (15.6kbps) and overdrive (110kbps) speeds.

**Standard DMA Controller**

The standard DMA controller allows automatic one-way data transfer between two entities. These entities can be either memories or peripherals. The transfers are done without using CPU resources. The following transfer modes are supported:

- 4-channel
- Peripheral to data memory
- Data memory to peripheral
- Data memory to data memory
- Event support

All DMA transactions consist of an AHB burst read into the DMA FIFO, followed immediately by an AHB burst write from the FIFO.

The MAX32655 provides one instance of the standard DMA controller.

**Security****AES**

The dedicated hardware-based AES engine supports the following algorithms:

- AES-128
- AES-192
- AES-256

The AES keys are automatically generated by the engine and stored in dedicated flash to protect against tampering. Key generation and storage is transparent to the user.

**True Random Number Generator (TRNG) Non-Deterministic Random Bit Generator (NDRBG)**

The device provides a non-deterministic entropy source that can be used to generate cryptographic seeds or strong encryption keys as part of an overall framework for a secure customer application.

Software can use random numbers to trigger asynchronous events that add complexity to program execution to thwart replay attacks or key search methodologies.

The TRNG can support the system-level validation of many security standards. Maxim Integrated will work directly with the customer's validation laboratory to provide the laboratory with any required information. Contact Maxim Integrated for details of compliance with specific standards.

**CRC Module**

A cyclic redundancy check (CRC) hardware module provides fast calculations and data integrity checks by application

software. It supports a user-defined programmable polynomial up to 32-bits. Direct memory access copies data into the CRC module so that CRC calculations on large blocks of memory are performed with minimal CPU intervention. Examples of common polynomials are depicted in [Table 11](#).

**Table 11. Common CRC Polynomials**

| ALGORITHM       | POLYNOMIAL EXPRESSION                                                                                             | ORDER          | POLYNOMIAL | CHECK          |
|-----------------|-------------------------------------------------------------------------------------------------------------------|----------------|------------|----------------|
| CRC-32-ETHERNET | $x^{32} + x^{26} + x^{23} + x^{22} + x^{16} + x^{12} + x^{11} + x^{10} + x^8 + x^7 + x^5 + x^4 + x^2 + x^1 + x^0$ | 0xEDB8<br>8320 | LSB        | 0xDEBB<br>20E3 |
| CRC-CCITT       | $x^{16} + x^{12} + x^5 + x^0$                                                                                     | 0x0000<br>8408 | LSB        | 0x0000<br>F0B8 |
| CRC-16          | $x^{16} + x^{15} + x^2 + x^0$                                                                                     | 0x0000<br>A001 | LSB        | 0x0000<br>B001 |
| USB DATA        | $x^{16} + x^{15} + x^2 + x^0$                                                                                     | 0x8005<br>0000 | LSB        | 0x800D<br>0000 |
| PARITY          | $x^1 + x^0$                                                                                                       | 0x0000<br>0001 | MSB        | —              |

### Secure Communications Protocol Bootloader (SCPBL)

The MAX32655 does not support an SCPBL. The user must use either JTAG or SWD to load firmware for execution.

### Secure Boot

Following every reset, the device performs a secure boot to confirm the root of trust has not been compromised. The secure boot verifies the digital signature of the program memory to confirm it has not been modified or corrupted, ensuring the trustworthiness of the application software. Failure to verify the digital signature will transition the device to safe mode, which prevents execution of the customer code.

### Debug and Development Interface (SWD, JTAG)

The serial wire debug (SWD) interface is used for code loading and debug for the CM4. The JTAG interface is provided for the RV32. All devices in mass production have the debugging/development interface enabled.

## Applications Information

### Bypass Capacitors

The proper use of bypass capacitors reduces noise generated by the IC into the ground plane. The [Pin Descriptions](#) table indicates which pins should be connected to bypass capacitors, and the appropriate ground plane.

It is recommended that one instance of a bypass capacitor should be connected to each pin/ball of the IC package. For example, if the [Pin Descriptions](#) table shows four device pins associated with voltage supply A, a separate capacitor should be connected to each pin for a total of four capacitors.

Capacitors should be placed as close as possible to their corresponding device pins. Pins which recommend more than one value of capacitor per pin should place them in parallel with the lowest value capacitor first, closest to the pin.

## Ordering Information

| PART          | UART | SPI<br>QUAD<br>w/ 3<br>CHIP<br>SELECTS | I <sup>2</sup> C | PULSE<br>TRAINS | EXTERNAL<br>ADC<br>INPUTS | COMPARATORS | LOW-<br>POWER<br>UART | PIN-PACKAGE                                  |
|---------------|------|----------------------------------------|------------------|-----------------|---------------------------|-------------|-----------------------|----------------------------------------------|
| MAX32655GXG+  | 4    | 2                                      | 3                | 4               | 8                         | 4           | 2                     | 81 CTBGA<br>8mm x 8mm<br>0.8mm pitch         |
| MAX32655GXG+T | 4    | 2                                      | 3                | 4               | 8                         | 4           | 2                     | 81 CTBGA<br>8mm x 8mm<br>0.8mm pitch         |
| MAX32655GWY+  | 2    | 1                                      | 1                | 2               | 0                         | 0           | 0                     | 60 WLP<br>3.13mm x<br>3.25mm<br>0.35mm pitch |
| MAX32655GWY+T | 2    | 1                                      | 1                | 2               | 0                         | 0           | 0                     | 60 WLP<br>3.13mm x<br>3.25mm<br>0.35mm pitch |

*T = Tape and reel.*

## Revision History

| REVISION<br>NUMBER | REVISION<br>DATE | DESCRIPTION                                                                                                                                                                                                                                                                                             | PAGES<br>CHANGED                      |
|--------------------|------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------|
| 0                  | 8/20             | Release for intro                                                                                                                                                                                                                                                                                       | —                                     |
| 1                  | 9/21             | Added 63 WLP <i>Pin Configuration</i> , <i>Pin Descriptions</i> , and <i>Package Information</i> .<br>Updated the <i>Electrical Characteristics</i> and <i>Ordering Information</i> .                                                                                                                   | 1, 7, 11, 32–36,<br>41, 52            |
| 2                  | 11/21            | Removed 63 WLP package and replaced with 60 WLP in <i>Pin Configuration</i> , <i>Pin Descriptions</i> , <i>Package Information</i> , <i>General Description</i> , and <i>Detailed Description</i> .<br>Updated <i>Ordering information</i> to reflect package change to MAX32655GWY+ and MAX32655GWY+T. | 1, 7, 32–36, 38,<br>41, 42, 46–49, 52 |

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